L6460

## SPI configurable stepper and DC multi motor driver

## Features

- Operating supply voltage from 13 V to 38 V
- 4 full bridge driver configurable in multi-motor application to drive:
- 2 DC and 1 stepper motor
- 4 DC motor
- Bridge 1 and $2\left(\mathrm{R}_{\mathrm{DSon}}=0.60 \Omega\right)$ can be configured to work as:
- Dual full bridge driver
- Super DC driver
- 2 half bridge driver
- 1 super half bridge
- 2 power switches
- 1 super power switch

■ Bridge 3 and $4\left(\mathrm{R}_{\mathrm{DSon}}=0.85 \Omega\right)$ can be configured to work as:

- Same as bridges 1 and 2, listed above
- Stepper motor driver: up to $1 / 16$ microstepping
- 2 buck regulators (bridge 3)
- 1 super buck regulator
- Battery charger (bridge 4)
- Power supply management
- One switching buck regulator
- One switching regulator controller
- One linear regulator
- One battery charger
- Fully protected through
- Thermal warning and shutdown
- Overcurrent protection
- Undervoltage lock-out
- SPI interface
- Programmable watchdog function
- Integrated power sequencing and supervisory functions with fault signaling through serial interface and external reset pin
■ Very low power dissipation in shut-down mode (~35 mW)


Auxiliary features

- Multi-channels 9 bit ADC
- 2 operational amplifiers
- Digital comparator
- 2 low voltage power switches
- 3 general purpose PWM generators
- 14 GPIOs


## Description

The L6460 is optimized to control and drive multimotor system providing a unique level of integration in term of control, power and auxiliary features. Thanks to the high configurability L6460 can be customized to drive different motor architectures and to optimize the number of embedded features, such as the voltage regulators, the high precision $A / D$ converter, the operational amplifier and the voltage comparators. The possibility to drive simultaneously stepper and DC motor makes L6460 the ideal solution for all the application featuring multi motors.

Table 1. Device summary

| Order code | Package | Packing |
| :---: | :---: | :---: |
| L6460 | TQFP64 | Tray |
|  |  | Tape and reel |

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## 1 General description

### 1.1 Overview

L6460 offers the possibility to control and power multi motor systems, through the management of simultaneous driving of stepper and DC motor. A number of features can be configured through the digital interface (SPI), including 3 voltage regulators, 1 high precision A/D converter, 2 operational amplifiers and 14 configurable GPIOs.
The high flexibility allows the possibility to configure two, one full or half bridge to work as power stage featuring additional voltage buck regulators.

Figure 1. Block diagram


Note: $\quad$ See following Chapter 2 for a detailed description of possible configurations.

### 1.2 Pin connection

Figure 2. Pin connection


### 1.3 Pin list

Table 2. Pins configuration

| Pin \# | Pin name | Description | Type |
| :---: | :---: | :---: | :---: |
| 1 | DC1_PLUS | Bridge 1 phase "plus" output | Output |
| 2 | $\mathrm{V}_{\text {SWDRV_SNS }}$ | Switching regulator controller sense | Analog input |
| 3 | $\mathrm{V}_{\text {SWDRV_FB }}$ | Switching regulator controller feedback | Analog input |
| 4 | GPIO4 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 5 | GPIO3 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 6 | DC1_MINUS | Bridge 1 phase "minus" output | Output |
| 7 | DC1_MINUS | Bridge 1 phase "minus" output | Output 1 |
| 8 | GND1 | Ground pin for bridge $1^{(1)(2)(3)}$ | Power/digital |
| 9 | GND2 | Ground pin for bridge $2^{(1)(2)(3)}$ | Power/digital |
| 10 | DC2_MINUS | Bridge 2 phase "minus" output | Output |
| 11 | DC2_MINUS | Bridge 2 phase "minus" output | Output |
| 12 | GPIO2 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 13 | GPIO1 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 14 | GPIOO | General purpose I/O | Analog Input - CMOS input |
| 15 | nSS | SPI chip select pin | CMOS input |
| 16 | DC2_PLUS | Bridge 2 phase "plus" output | Output |
| 17 | DC2_PLUS | Bridge 2 phase "plus" output | Output |
| 18 | $\mathrm{V}_{\text {Supply }}$ | Main voltage supply | Power input |
| 19 | MISO | SPI serial data output | CMOS output |
| 20 | MOSI | SPI serial data input | CMOS input |
| 21 | $V_{\text {LINmain_FB }}$ | Linear main regulator feedback | Analog input |
| 22 | $\mathrm{V}_{\text {LINmain_OUT }}$ | Linear main regulator output | Power output |
| 23 | GPIO 8 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 24 | $\mathrm{V}_{\text {SWmain_SW }}$ | Main switching regulator switching output | Power output |
| 25 | $\mathrm{V}_{\text {Supply }}$ | Main voltage supply | Power Input |
| 26 | $\mathrm{V}_{\text {SWmain_FB }}$ | Main switching regulator feedback pin | Analog input |
| 27 | $\mathrm{V}_{\text {REF_FB }}$ | Regulator voltage feedback | Analog input |
| 28 | $\mathrm{I}_{\text {REF_FB }}$ | Regulator current feedback | Analog input |
| 29 | SCLK | SPI input clock pin | CMOS input |
| 30 | $\mathrm{V}_{\text {Supply }}$ | Main voltage supply | Power input |
| 31 | DC4_PLUS | Bridge 4 phase "plus" output | Output |
| 32 | N.C. | Not connected |  |
| 33 | DC4_SENSE | Bridge 4 sense output ${ }^{(4)}$ | Output |
| 34 | nAWAKE | Device wake up | CMOS input |

Table 2. Pins configuration (continued)

| Pin \# | Pin name | Description | Type |
| :---: | :---: | :---: | :---: |
| 35 | GPIO12 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 36 | GPIO13 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 37 | GPIO14 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 38 | N.C. | Not connected |  |
| 39 | DC4_MINUS | Bridge 4 phase "minus" output | Output |
| 40 | DC4_SENSE | Bridge 4 sense output ${ }^{(4)}$ | Output |
| 41 | DC3_SENSE | Bridge 3 sense output ${ }^{(4)}$ | Output |
| 42 | DC3_MINUS | Bridge 3 phase "minus" output | Output |
| 43 | N.C. | Not connected | , |
| 44 | GPIO11 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 45 | GPIO10 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 46 | GPIO9 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 47 | GPIO5 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 48 | DC3_SENSE | Bridge 3 sense output ${ }^{(4)}$ | Output |
| 49 | N.C. | Not connected |  |
| 50 | DC3_PLUS | Bridge 3 phase "plus" output | Output |
| 51 | $\mathrm{V}_{\text {Supply }}$ | Main voltage supply | Power input |
| 52 | nRESET | Open drain system reset pin | CMOS Input/output |
| 53 | $\mathrm{V}_{3 \mathrm{v} 3}$ | Internal 3.3 volt regulator | Power Input/output |
| 54 | $\mathrm{V}_{\text {Supplylnt }}$ | Internal voltage supply | Power Input |
| 55 | GPIO7 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 56 | $\mathrm{V}_{\text {GPIO_SPI }}$ | Low voltage pins power supply | Power input |
| 57 | GPIO6 | General purpose I/O | Analog In/Out - CMOS bi-dir |
| 58 | V SWDRV_SW | Switching regulator controller source input | Power input |
| 59 | $\mathrm{V}_{\text {SWDRV_GATE }}$ | Switching driver gate drive pin | Analog output |
| 60 | $V_{\text {Pump }}$ | Charge pump voltage | Power Input/output |
| 61 | CPH | Charge pump high switch pin | Power Input/output |
| 62 | CPL | Charge pump low switch pin | Power Input/output |
| 63 | $\mathrm{V}_{\text {Supply }}$ | Main voltage supply | Power input |
| 64 | DC1_plus | Bridge 1 phase "plus" output | Output |
| E_Pad | GND_PAD | (1)(2)(3) |  |

1. These pins must be connected all together to a unique PCB ground.
2. Bridges 1 and 2 have 2 ground pads: one is bonded to the relative ground pin (GND1 or GND2) and the other is connected to exposed pad (E_Pad) ground ring. This makes the bond wires testing possible by forcing a current between E-Pad and GND1 or GND2 pins and using the other pin as sense pin to measure the resistance of E-Pad bonding. (N.B: grounds of two bridges are internally connected together)
3. The analog ground is connected to exposed pad E-Pad.
4. The pin must be tied to ground if bridge is not used as a stepper motor.

## 2 L6460's main features

L6460 includes the following circuits:

- Four widely configurable full bridges:
- Bridges 1 and 2:
- Diagonal $\mathrm{R}_{\mathrm{DSon}}$ : $0.6 \Omega$ typ.
- Max operative current = 2.5 A .
- Bridges 3 and 4:
- Diagonal $\mathrm{R}_{\text {DSon: }} 0.85 \Omega$ typ.
- Max operative current = 1.5 A .
- Possible configurations for each bridge are the following:
- Bridge 1:
- DC motor driver.
- $\quad$ Super DC (bridge 1 and 2 paralleled form superbridge1).
- 2 independent half bridges.
- $\quad 1$ super half bridge (bridge 1 side $A$ and bridge 1 side $B$ paralleled form superhalfbridge1).
- 2 independent switches (high or low side).
- 1 super switch (high or low side).
- Bridge 2 has the same configurations of bridge 1.
- Bridge 3 has the same configurations of bridge 1 (bridge 3 and 4 paralleled form superbridge2) plus the following:
- $\quad 1 / 2$ stepper motor driver.
- 2 buck regulators ( $\mathrm{V}_{\text {AUX1_Sw, }} \mathrm{V}_{\text {AUX2_sw }}$ ).
- 1 Super buck regulator ( $\mathrm{V}_{\mathrm{AUx} 1 / 2 \_ \text {_sw }}$ ).
- Bridge 4 has the same configurations of bridge 1 plus the following:
- $1 / 2$ stepper motor driver.
- 1 super buck regulator ( $\mathrm{V}_{\text {AUX3_SW }}$ ).
- Battery charger.
- One buck type switching regulator ( $\mathrm{V}_{\mathrm{SW} \text { main }}$ ) with:
- Output regulated voltage range: 1-5 Volts.
- Output load current: 3.0 A.
- Internal output power DMOS.
- Internal soft start sequence.
- Internal PWM generation.
- Switching frequency: $\sim 250 \mathrm{kHz}$.
- Pulse skipping strategy control.
- One switching regulator controller (VSWDRV) with:
- Output regulated voltage range: 1-30 Volts.
- Selectable current limitation.
- Internal PWM generation.
- Pulse skipping strategy control.
- One linear regulator ( $\mathrm{V}_{\text {LINmain }}$ ) that can be used to generate low current/low ripple
voltages. This regulator can be used to drive an external bipolar pass transistor to generate high current/low ripple output voltages.
- One bidirectional serial interface with address detection so that different ICs can share the same data bus.
- Integrated power sequencing and supervisory functions with fault signaling through serial interface and external reset pin.
- Fourteen general purpose I/Os that can be used to drive/read internal/external analog/logic signals.
- One 8-bit/9-bit A/D converter ( $100 \mathrm{kS} / \mathrm{s}$ @ 9-bit, $200 \mathrm{kS} / \mathrm{s}$ @ 8 -bit). It can be used to measure most of the internal signals, of the input pins and a voltage proportional to IC temperature.
- Current sink DAC:
- Three output current ranges: up to 0.64/6.4/64 mA.
- 64 (6-bit programmable) available current levels for each range.
- 5 V output tolerant.
- Two operational amplifiers:
- $\quad 3.3 \mathrm{~V}$ supply, rail to rail input compatibility, internally compensated.
- They can have all pins externally accessible or can be internally configured as a buffer o make internal reference voltages available outside of the chip.
- Unity gain bandwidth > 1 MHz .
- They can also be set as comparators with 3.3 V input compatibility and low offset.
- Two 3.3 V pass switches with $1 \Omega \mathrm{R}_{\mathrm{DS} \text { on }}$ and short circuit protected.
- Programmable watchdog function.
- Thermal shutdown protection with thermal warning capability.
- Very low power dissipation in "low power mode" ( $\sim 35 \mathrm{~mW}$ )

L6460 is intended to maximize the use of its components, so when an internal circuit is not used it could be employed for other applications. Bridge 3, for example, can be used as a full bridge or to implement two switching regulators with synchronous rectification: to obtain this flexibility L6460 includes 2 separate regulation loops for these regulators; when the bridge is used as a motor driver, the 2 regulation loops can be redirected on general purpose I/Os to leave the possibility to assembly a switching regulator by only adding an external FET.

## 3 Electrical specifications

### 3.1 Absolute maximum rating

The following specifications define the maximum range of voltages or currents for L6460.
Stresses above these absolute maximum specifications may cause permanent damage to the device. Exposure to absolute maximum ratings for extended periods may affect device reliability.

Table 3. Absolute maximum ratings

| Parameter | Description | Test condition | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {Supply }}$ | $V_{\text {Supply }}$ voltage |  |  | 40 | V |
| $\mathrm{V}_{\text {GPIO_SPI }}$ | $\mathrm{V}_{\text {GPIO_SPI }}$ voltage |  |  | 3.9 | V |
| $\mathrm{V}_{3 \mathrm{~V} 3 \text { pin }}$ | $\mathrm{V}_{3} \mathrm{~V}_{3}$ voltage |  | -0.3 | 3.9 | V |
| $\mathrm{V}_{\text {SW }}$ | Switching regulators output pin voltage range |  | -1 | $\mathrm{V}_{\text {Supply }}$ | V |
| $\mathrm{V}_{\text {SW_pulse }}$ | Switching regulators min pulsed voltage | tpulse < 500ns | -3 |  | V |
| $\mathrm{V}_{\text {Pump }}$ | Charge pump voltage | (1) |  | 15 | V |
| $\mathrm{T}_{J}$ | Junction temperature ${ }^{(2)}$ | Storage | -40 | 190 | ${ }^{\circ} \mathrm{C}$ |
|  |  | Operating | -40 | TSD | ${ }^{\circ} \mathrm{C}$ |

1. This value is useful to define the voltage rating for external capacitor to be connected from $\mathrm{V}_{\text {Pump }}$ to $\mathrm{V}_{\text {Supply }} . \mathrm{V}_{\text {Pump }}$ is internally generated and can never be supplied by external voltage source nor is intended to provide voltage to external loads.
2. TSD is the thermal shut down temperature of the device.

### 3.2 Operating ratings specifications

Table 4. IC operating ratings

| Parameter | Description | Test <br> condition | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {Supply }}$ | $\mathrm{V}_{\text {Supply }}$ voltage range |  | $13^{(1)}$ | 38 | V |
| $\mathrm{I}_{\text {Supply }}$ | $\mathrm{V}_{\text {Supply }}$ operative current | ${ }^{(2)}$ |  | 15 | mA |
| $\mathrm{I}_{\text {Shut_down }}$ | $\mathrm{V}_{\text {Supply }}$ shut down state current |  |  | 1.5 | mA |
| $\mathrm{~V}_{\text {GPIO_SPI }}$ | $\mathrm{V}_{\text {GPIO_SPI }}$ voltage range |  | 2.4 | 3.6 | V |
| $\mathrm{I}_{\text {VGPIO_SPI }}$ | $\mathrm{V}_{\text {GPIO_SPI }}$ operative current | ${ }^{(3)}$ |  | 0.4 | mA |
| $\mathrm{~V}_{\text {3v3 }}$ | 3.3V input pin voltage range |  |  | 3.6 | V |
| $\mathrm{~V}_{\text {LINmain_OUT }}$ | Output pin voltage range | $(4)$ | 0 | $\mathrm{~V}_{\text {Supply }}$ | V |
| $\mathrm{V}_{\text {LINmain_FB }}$ | Feedback pin voltage range |  | 0 | 3.6 | V |
| $\mathrm{~V}_{\text {SWmain_SW }}$ | Output pin voltage range | $(4)$ | -1 | $\mathrm{~V}_{\text {supply }}$ | V |
| $\mathrm{V}_{\text {SWDRV_SW }}$ | $\mathrm{V}_{\text {SWDRV_SW }}$ pin voltage range | $(4)$ | -1 | $\mathrm{~V}_{\text {Supply }}$ | V |

Table 4. IC operating ratings

| Parameter | Description | Test <br> condition | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {SWDRV_GATE }}$ | Gate drive pin voltage |  | 0 | $\mathrm{~V}_{\text {Pump }}$ | V |
| $\mathrm{V}_{\text {SWDRV_SNS }}$ | Sense pin voltage |  | $\mathrm{V}_{\text {Supply }}$ <br> -3 V | $\mathrm{~V}_{\text {Supply }}$ | V |
| $\mathrm{T}_{\mathrm{J}}$ | Junction temperature | Operating | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |

1. For $\mathrm{V}_{\text {supply }}$ lower than 21 V an external resistor between $\mathrm{V}_{\text {supply }}$ and $\mathrm{V}_{\text {supply int }}$ pins are required. For $\mathrm{V}_{\text {supply }}^{\text {supply }}$ lower than 15 V external diodes for charge pump are required.
2. Operating supply current is measured with system regulators operating but not loaded.
3. Operating $\mathrm{V}_{\mathrm{GPIO}}$ SPI current is measured with all circuits supplied by $\mathrm{V}_{\mathrm{GPIO}}$ SPI (GPIO's, operational amplifiers and pass switches) enabled but not loaded.
4. The external components connected to the pin must be chosen to avoid that the voltage exceeds this operative range.

### 3.3 Electrical characteristics

Table 5. Electrical characteristics

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {SupplyInt }}$ regulator |  |  |  |  |  |  |
| $\mathrm{V}_{\text {S_Int }}$ | $\mathrm{V}_{\text {Supplylnt }}$ output voltage | (1) | 18 | 19.5 | 21 | V |
| IS_Int | $\mathrm{V}_{\text {SupplyInt }}$ Operative current | (2) |  | 11 |  | mA |
| Charge pump $\mathrm{V}_{\text {Pump }}$ |  |  |  |  |  |  |
| $V_{\text {Pump }}$ | Charge pump voltage | $\mathrm{V}_{\text {Supply }}=32 \mathrm{~V}$ | $\begin{array}{\|l\|l} V_{\text {Supply }} \\ +10.5 \end{array}$ | $\begin{aligned} & \mathrm{V}_{\text {Supply }} \\ & +12.5 \end{aligned}$ | $\begin{aligned} & V_{\text {Supply }} \\ & +14.5 \end{aligned}$ | V |
| $\mathrm{F}_{\text {Pump }}$ | $V_{\text {Pump }}$ clock frequency | $\mathrm{F}_{\text {OSC }}=16 \mathrm{MHz}$ typ |  | $\underset{4}{\mathrm{FOSC} / 6}$ |  | kHz |
| V3V3 regulator |  |  |  |  |  |  |
| $\mathrm{V}_{3 \mathrm{~V} 3}$ | $\mathrm{V}_{3 \mathrm{v} 3}$ output voltage | $\mathrm{V}_{\text {Supply }}=32 \mathrm{~V}$ | 3.15 | 3.3 | 3.45 | V |
| Power on reset |  |  |  |  |  |  |
| $\mathrm{V}_{\text {Supply_POR_valid }}$ | $\mathrm{V}_{\text {Supply }}$ voltage for POR valid | $\mathrm{I}_{\text {nRESET }}=1 \mathrm{~mA}$ | 4 |  |  | V |
| $V_{\text {Supply_POR_fall }}$ | $V_{\text {Supply }}$ POR falling threshold | $\mathrm{V}_{\text {Supply }}$ falling | 6 |  | 8 | V |
| ${ }^{\text {t }}$ Supply_POR_filt | $V_{\text {Supply }}$ POR filter Time |  |  | 3 |  | $\mu \mathrm{s}$ |
| $\mathrm{V}_{3} \mathrm{~V} 3$ _POR_fall | $V_{3 v 3}$ POR falling threshold | $V_{3 V 3}$ falling | 1.9 | 2.2 |  | V |
| $\mathrm{V}_{3} \mathrm{~V}_{3}$ PORR_rise | $\mathrm{V}_{3 \mathrm{v} 3}$ POR rising threshold | $V_{3 V 3}$ rising |  | 2.7 |  | V |
| V3V3_POR_hys | $\mathrm{V}_{3 \mathrm{v} 3}$ POR hysteresis |  |  | 0.5 |  | V |
| t ${ }_{\text {VV3_POR_filt }}$ | $V_{3 v 3}$ POR filter time |  |  | 1.5 |  | $\mu \mathrm{s}$ |
| nRESET circuit |  |  |  |  |  |  |
| V ${ }_{\text {nRST_L }}$ | nRESET low level output voltage | $\mathrm{I}=10 \mathrm{~mA}$ |  |  | 0.4 | V |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {nRST_fall }}$ | nRESET fall time | $\begin{aligned} & \mathrm{I}=1 \mathrm{~mA} \\ & \mathrm{C}=50 \mathrm{pF}^{(3)} \end{aligned}$ |  |  | 15 | ns |
| $\mathrm{t}_{\text {nRST_del }}$ | nRESET delay time | (4) |  |  | 150 | ns |
| V Supply_UV_f | $V_{\text {Supply }}$ falling threshold |  | 10.2 | 11 | 11.8 | V |
| V Supply_UV_r | $V_{\text {Supply }}$ rising threshold |  | 10.5 | 11.5 | 12.5 | V |
| $V_{\text {Supply_UV_hys }}$ | $V_{\text {Supply }}$ hysteresis |  | 0.3 | 0.5 | 0.7 | V |
| ${ }^{\text {t }}$ Supply_UV | $V_{\text {Supply }}$ UV filter time |  |  | 3.5 |  | $\mu \mathrm{s}$ |
| VS_Int_UV_f | $\mathrm{V}_{\text {SupplyInt }}$ falling threshold |  | 9.7 | 10.7 | 11.7 | V |
| $\mathrm{V}_{\text {S_Int_UV_r }}$ | $\mathrm{V}_{\text {Supplylnt }}$ rising threshold |  | 10.6 | 11.4 | 12.2 | V |
| V ${ }_{\text {S_Int_UV_hys }}$ | $\mathrm{V}_{\text {SupplyInt }}$ hysteresis |  | 0.4 | 0.7 | 1 | V |
| ts_Int_UV | $\mathrm{V}_{\text {SupplyInt }}$ UV filter time |  |  | 3.5 |  | $\mu \mathrm{s}$ |
| $V_{\text {Pump_UV_f }}$ | $\mathrm{V}_{\text {Pump }}$ falling threshold |  | $\begin{gathered} V_{\text {Supply }} \\ +7 \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\text {Supply }} \\ +7.5 \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\text {Supply }} \\ +8 \end{gathered}$ | V |
| V Pump_UV_r | $\mathrm{V}_{\text {Pump }}$ rising threshold |  | $\begin{gathered} \mathrm{V}_{\text {Supply }} \\ +7.5 \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\text {Supply }} \\ +8 \end{gathered}$ | $\begin{gathered} \mathrm{V}_{\text {Supply }} \\ +8.5 \end{gathered}$ | V |
| $\mathrm{V}_{\text {Pump_UV_hys }}$ | $\mathrm{V}_{\text {Pump }}$ hysteresis |  | 0.3 | 0.5 | 0.7 | V |
| tpump_uv | $V_{\text {Pump }}$ UV filter time | , |  | 3.5 |  | $\mu \mathrm{s}$ |
| VGPIO_SPI_UV_f | $\mathrm{V}_{\text {GPIO_SPI }}$ falling threshold |  | 1.8 | 2 |  | V |
| $\mathrm{V}_{\text {GPIO_SPI_UV_r }}$ | $\mathrm{V}_{\text {GPIO_SPI }}$ rising threshold |  |  | 2.2 | 2.4 | V |
| VGPIO_SPI_hys | $\mathrm{V}_{\text {GPIO_SPI }}$ hysteresis |  | 200 | 250 | 300 | mV |
| $\mathrm{t}_{\text {GPIO_SPI_UV }}$ | $\mathrm{V}_{\text {GPIO_SPI }}$ UV filter time |  |  | 3.5 |  | $\mu \mathrm{s}$ |


| TSD circuit |  |  |  |  |  |  |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{T}_{\text {TSD }}$ | Thermal shut down <br> temperature |  |  |  |  |  |
| $\mathrm{T}_{\text {WARM }}$ | Warming temperature |  | 170 |  | ${ }^{\circ} \mathrm{C}$ |  |
| $\mathrm{T}_{\text {DIFF }}$ | Thermal shut down to warming <br> difference |  | 140 |  |  |  |
| $\mathrm{t}_{\text {TSD_FILT }}$ | Thermal shut down filter time |  | 30 | ${ }^{\circ} \mathrm{C}$ |  |  |
| $\mathrm{t}_{\text {WARM_FILT }}$ | Warming filter time |  |  | 8 |  | $\mu \mathrm{c}$ |

## Watchdog

| WD_T ${ }_{\text {clk }}$ | Watchdog clock period |  |  | $\underset{2_{\text {ssc }}^{22}}{ }$ * |  | s |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Internal clock |  |  |  |  |  |  |
| $\mathrm{F}_{\text {osc }}$ | Oscillator frequency | $\mathrm{V}_{3 \mathrm{~V} 3}=3.3 \mathrm{~V}$ | 14.1 | 16 | 17.6 | MHz |
| nAWAKE function |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IL }}$ | nAWAKE low logic level voltage |  |  |  | 0.8 | V |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{IH}}$ | nAWAKE high logic level <br> voltage |  | 1.6 |  |  | V |
| $\mathrm{~V}_{\text {HYS }}$ | nAWAKE input hysteresis |  |  | 0.25 |  | V |
| $\mathrm{I}_{\text {OUT }}$ | nAWAKE pin output current | nAWAKE $=0 \mathrm{~V}^{(5)}$ | -0.72 |  | -2 | mA |
| $\mathrm{I}_{\text {INP }}$ | nAWAKE pin input current | nAWAKE $=0.8 \mathrm{~V}^{(5)}$ | 0.2 |  | 0.4 | mA |
| $\mathrm{t}_{\text {AWAKEFILT }}$ | Filter time |  |  | 1.2 |  | $\mu \mathrm{~s}$ |

## Main linear regulator

| $\mathrm{V}_{\text {drop }}$ | Drop out voltage | $\begin{aligned} & \mathrm{V}_{\text {drop }}= \\ & \mathrm{V}_{\text {supply }}-\mathrm{V}_{\text {LINmain_OUT }} \end{aligned}$ | 2 |  |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{IPD}^{\text {P }}$ | Internal switch pull down current | Linear Main Regulator disabled; $\mathrm{V}_{\text {LINmain_OUT }}=1 \mathrm{~V}$ |  |  | , | mA |
| VLINmain_Ref | Feedback reference voltage |  | 0.776 | 0.8 | 0.824 | V |
| ILINmain_Ref | Feedback pin input current |  | -2 |  | 2 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {outLINMax }}$ | Maximum output current | $\mathrm{V}_{\text {LINmain_OUT }}=\mathrm{V}_{\text {supply }}-2 \mathrm{~V}$ | 10 |  |  | mA |
| $\mathrm{I}_{\text {short }}$ | Output short circuit current | $V_{\text {LINmain_OUT }}=0 \mathrm{~V}$, <br> $\mathrm{V}_{\text {LINmain_FB }}=0 \mathrm{~V}$ | 12 | 24 | 32 | mA |
| $\Delta \mathrm{V}_{\text {out }} / \mathrm{V}_{\text {o }}$ | Load regulation | $0 \leq \mathrm{l}_{\text {load }} \leq \mathrm{I}_{\text {outLINMax }}{ }^{(6)}$ |  |  | 0.8 | \% |
| $\Delta \mathrm{V}_{\text {out }} / \Delta \mathrm{V}_{\text {Supply }}$ | Line regulation | $\mathrm{l}_{\text {load }}=10 \mathrm{~mA}^{(6)}$ |  |  | 0.2 | \% |
| $V_{\text {loop_acc }}$ | Loop voltage accuracy |  |  | $\pm 2.5$ |  | \% |
| VLIN_UV_f | Undervoltage falling threshold | (7) | 84.5 | 87 | 89.5 | \% |
| VLIN_UV_r | Undervoltage rising threshold | (7) | 90.5 | 93 | 95.5 | \% |
| VLIN_UV_hys | Undervoltage hysteresis |  |  | 6 |  | \% |
| $\mathrm{t}_{\text {prim_uv }}$ | Under voltage deglitch filter |  |  | 5 |  | $\mu \mathrm{s}$ |
| Main switching regulator |  |  |  |  |  |  |
| $V_{\text {FBREF }}$ | Main switching regulator feedback reference voltage | SelFBref = '00' | 0.776 | 0.8 | 0.824 | V |
|  |  | SelFBref = '01' ${ }^{(8)}$ | 0.97 | 1 | 1.03 | V |
|  |  | SelFBref = '10' | 2.425 | 2.5 | 2.575 | V |
|  |  | SelFBref $=$ ' 11 ' | 2.91 | 3 | 3.09 | V |
| $\mathrm{I}_{\mathrm{Q}}$ | Output leakage current | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C}$ | -40 |  | +40 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Q}}$ LP | Output leakage current in "low power mode" | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V} \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ | -15 |  | +15 | $\mu \mathrm{A}$ |
| ISWmain_FB | $\mathrm{V}_{\text {SWmain_FB }}$ pin current | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {SWmain_OUT }}$ | Output voltage range | (9) | 0.8 |  | 5 | V |
| $\mathrm{I}_{\text {load }}$ | Maximum output load current | $\mathrm{V}_{\text {Supply }}=36 \mathrm{~V}$ | 0.002 |  | 3 | A |
| $\mathrm{R}_{\text {DSonHS }}$ | Internal high side $\mathrm{R}_{\mathrm{DSon}}$ | $\begin{aligned} & \mathrm{I}_{\text {load }}=1 \mathrm{~A} \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 0.33 | 0.95 | $\Omega$ |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {loop }}$ | Loop voltage accuracy |  |  | $\pm 3 \%$ |  |  |
| $\mathrm{V}_{\text {SW_UV_f }}$ | Under voltage falling threshold | (10) | 84.5 | 87 | 89.5 | \% |
| $\mathrm{V}_{\text {SW_UV_r }}$ | Under voltage rising threshold | (10) | 90.5 | 93 | 95.5 | \% |
| $\mathrm{V}_{\text {Sw_UV_hys }}$ | Under voltage hysteresis |  |  | 6 |  | \% |
| $t_{\text {prim_uv }}$ | Under voltage deglitch filter |  |  | 5 |  | $\mu \mathrm{s}$ |
| $\mathrm{l}_{\text {limit }}$ | Current limit protection | $\begin{aligned} & \text { Selllimit ="0" } \\ & \text { Selllimit ="1" } \end{aligned}$ | $\begin{aligned} & 3.3 \\ & 2.3 \end{aligned}$ | $\begin{gathered} 5 \\ 3.5 \end{gathered}$ |  | $\begin{aligned} & \mathrm{A} \\ & \mathrm{~A} \end{aligned}$ |
| $\mathrm{t}_{\text {deglitch }}$ | Current limit deglitch time |  | 50 |  |  | ns |
| t_lim | Current limit response time | Normal operating mode (no UV) ${ }^{(11)}$ |  | 450 | $650$ | ns |
| tı_limuV | Current limit response time in UV condition | UV condition ${ }^{(12)}$ |  | 200 | 400 | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Switching output rise time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=422 \Omega^{(13)} \end{aligned}$ | 5 |  | 30 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Switching output fall time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=10 \Omega^{(13)} \end{aligned}$ | 5 |  | 30 | ns |
| $\mathrm{F}_{\text {SW_PWM }}$ | Operating frequency |  |  | $\begin{gathered} \text { Fosc/6 } \\ 4 \end{gathered}$ |  | kHz |

## Switching regulator controller

| $V_{\text {GS_ext }}$ | Gate to source voltage for external FET |  |  | $V_{\text {Pump }}$ |  | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Isource | Source current | $\mathrm{V}_{\text {Pump }}=\mathrm{V}_{\text {Supply }}+12 \mathrm{~V}$ <br> $V_{\text {SWCTR_GATE }}=0 \mathrm{~V}$ | 25 |  | 50 | mA |
| $\mathrm{I}_{\text {SINK }}$ | Sink current | $\mathrm{V}_{\text {SWCTR_GATE }}=\mathrm{V}_{\text {Supply }}$ | 20 |  |  | mA |
| $\mathrm{t}_{\text {SINK }}$ | Sink discharge pulse time |  |  | 600 |  | ns |
| $R_{\text {sustain }}$ | Gate-source sustain resistance | (V $\mathrm{V}_{\text {SWCTR GATE }}$ - <br> $\left.\mathrm{V}_{\text {SWCTR_SRC }}\right)=0.2 \mathrm{~V}$ |  | 650 |  | $\Omega$ |
| $\mathrm{I}_{\mathrm{Q}}$ | Output leakage current | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | -40 |  | +40 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Q}}$ LP | Output leakage current in "Low Power Mode" | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ | -5 |  | +5 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {FBREF }}$ | Switching regulator feedback controller feedback reference voltage | SelFBref $=$ '00' ${ }^{(8)}$ | 0.776 | 0.8 | 0.824 | V |
|  |  | SelFBref = '01' | 0.97 | 1 | 1.03 | V |
|  |  | SelFBref = '10' | 2.425 | 2.5 | 2.575 | V |
|  |  | SelFBref = '11' | 2.91 | 3 | 3.09 | V |
| ISWDRV_FB | $\mathrm{V}_{\text {SWDRV_FB }}$ pin current | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {loop }}$ | Loop voltage accuracy |  |  | $\pm 3 \%$ |  |  |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VSWD_UV_f | Under voltage falling threshold | (14) | 84.5 | 87 | 89.5 | \% |
| VSWD_UV_r | Under voltage rising threshold | (14) | 90.5 | 93 | 95.5 | \% |
| $\mathrm{V}_{\text {SWD_UV_hys }}$ | Under voltage hysteresis |  |  | 6 |  | \% |
| $\mathrm{t}_{\text {prim_uv }}$ | Under voltage deglitch filter |  |  | 5 |  | $\mu \mathrm{s}$ |
| $\mathrm{V}_{\text {ovc }}$ | Over current threshold voltage |  | 250 | 300 | 350 | mV |
| $\mathrm{t}_{\text {deglitch }}$ | Current limit deglitch time |  | 50 |  |  | ns |
| $t_{\text {I_lim }}$ | Current limit response time | Normal operating mode (no UV) ${ }^{(11)}$ |  | 500 | 900 | ns |
| tı_limuV | Current Limit response time in UV condition. | UV condition ${ }^{(12)}$ |  | 380 | 550 | ns |
| $F_{\text {SWD_PWM }}$ | Operating frequency |  |  | $\mathrm{F}_{\text {osc }} / 64$ |  | kHz |
| Power bridges |  |  |  |  |  |  |
| $\mathrm{R}_{\text {DSon1_2 }}$ | Bridge 1 and 2 diagonal $\mathrm{R}_{\text {DSon }}$ | $\begin{aligned} & \mathrm{I}=1.4 \mathrm{~A}, \mathrm{~V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 0.6 | 1.1 | $\Omega$ |
| $\mathrm{R}_{\text {DSon3_4 }}$ | Bridge 3 and 4 diagonal $\mathrm{R}_{\text {DSon }}$ | $\begin{aligned} & \mathrm{I}=1 \mathrm{~A}, \mathrm{~V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ |  | 0.85 | 1.65 | $\Omega$ |
| $\mathrm{I}_{\text {MAX1_2 }}$ | Bridge 1 and 2 operative rms current |  |  |  | 2.5 | A |
| $I_{\text {MAX3_4 }}$ | Bridge 3 and 4 operative rms current |  |  |  | 1.5 | A |
| $\mathrm{I}_{\mathrm{dss}}$ | Output leakage current. | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C}$ | -50 |  | +50 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\mathrm{Q} \text { LP }}$ | Output leakage current in "low power mode" | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \end{aligned}$ | -10 |  | +10 | $\mu \mathrm{A}$ |
| loc_LS1_2 | Low side current protection for bridges 1 and $2^{(15)}$ | MtrXSideYILimSel[1:0]=00 <br> MtrXSideYILimSel[1:0]=01 <br> MtrXSideYILimSel[1:0]=10 <br> MtrXSideYILimSel[1:0]=11 <br> (16) | $\begin{aligned} & 0.6 \\ & 1.4 \\ & 2.4 \\ & 2.4 \end{aligned}$ | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 3 \end{aligned}$ | $\begin{aligned} & 1.6 \\ & 2.6 \\ & 3.6 \\ & 3.6 \end{aligned}$ | A |
| IOC_HS1_2 | High side current protection for bridges 1 and $2^{(15)}$ | MtrXSideYILimSel[1:0]=00 <br> MtrXSideYILimSel[1:0]=01 <br> MtrXSideYILimSel[1:0]=10 <br> MtrXSideYILimSel[1:0]=11 ${ }^{(1}$ <br> 6) | $\begin{aligned} & 0.7 \\ & 1.5 \\ & 2.5 \\ & 2.5 \end{aligned}$ | $\begin{aligned} & 1 \\ & 2 \\ & 3 \\ & 3 \end{aligned}$ | $\begin{aligned} & 1.7 \\ & 2.7 \\ & 3.7 \\ & 3.7 \end{aligned}$ | A |
| loc_LS3_4 | Low side current protection for bridges 3 and $4^{(15)}$ | $\begin{array}{\|l\|} \hline \text { MtrXSideYILimSel[1:0]=11 } \\ (17)(18) \end{array}$ | 1.55 |  | 2.5 | A |
| loc_HS3_4 | High side current protection for bridges 3 and $4^{(15)}$ | $\begin{aligned} & \text { MtrXSideYILimSel[1:0]=11 } \\ & 7{ }^{(1} \end{aligned}$ | 1.6 |  | 2.5 | A |
| $\mathrm{t}_{\text {filter }}$ | Current limit filter time |  | 2 |  | 5 | $\mu \mathrm{S}$ |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{\text {delay }}$ | Current limit delay time |  |  | 5 |  | $\mu \mathrm{S}$ |
| toc_off | Over current Off time | MtrXIlimitOffTimeY[1:0]=00 <br> MtrXIlimitOffTimeY[1:0]=01 <br> MtrXIlimitOffTimeY[1:0]=10 <br> MtrXIlimitOffTimeY[1:0]=11 <br> (19) |  | $\begin{gathered} 60 \\ 120 \\ 240 \\ 480 \end{gathered}$ |  | $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ <br> $\mu \mathrm{s}$ |
| $\mathrm{tr1} \mathrm{\_2}$ | Output rise time bridges 1 and 2 | $V_{\text {Supply }}=36 \mathrm{~V}$, resistive load between outputs: $\mathrm{R}=25 \Omega^{(20)}$ | 100 | 180 | 250 | ns |
| $\mathrm{t}_{\text {r3_4 }}$ | Output rise time bridges 3 and 4 | $V_{\text {Supply }}=36 \mathrm{~V}$, resistive load between outputs: $\mathrm{R}=36 \Omega^{(20)}$ | 50 | $100$ | 200 | ns |
| $\mathrm{t}_{\text {f1_2 }}$ | Output fall time bridges 1 and 2 | $V_{\text {Supply }}=36 \mathrm{~V}$, resistive load between outputs: $\mathrm{R}=25 \Omega^{(20)}$ | $100$ | 180 | 250 | ns |
| $\mathrm{t}_{\text {f3_4 }}$ | Output fall time bridges 3 and 4 | $V_{\text {Supply }}=36 \mathrm{~V}$, resistive load between outputs: $\mathrm{R}=36 \Omega^{(20)}$ | 50 | 125 | 250 | ns |
| $\mathrm{t}_{\text {deadRise }}$ | Anti crossover rising dead time |  | 100 | 300 | 450 | ns |
| $\mathrm{t}_{\text {deadFall }}$ | Anti crossover falling dead time | , | 100 | 300 | 450 | ns |
| $\mathrm{F}_{\text {PWM }}$ | Operating frequency |  |  | $\begin{array}{\|c} \mathrm{F}_{\mathrm{osc}} / 51 \\ 2 \end{array}$ |  | kHz |
| $\mathrm{t}_{\text {resp }}$ | Delay from PWM to output transition |  |  | 500 |  | ns |
| Bipolar stepper circuitry |  |  |  |  |  |  |
| $V_{\text {STEPREF }}$ | Reference voltage | SelStepRef =0 <br> SelStepRef =1 | $\begin{aligned} & 0.48 \\ & 0.72 \end{aligned}$ | $\begin{aligned} & 0.50 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & \hline 0.52 \\ & 0.78 \end{aligned}$ | V |
| $V_{\text {offset }}$ | Sense comparator offset |  | -12 |  | 12 | mV |
| $t_{\text {blk }}$ | Blanking time | StepBIkTime = '00' ${ }^{(8)}$ | 0.65 | 0.95 | 1.25 | $\mu \mathrm{s}$ |
|  |  | StepBIkTime = '01' | 1 | 1.45 | 1.9 | $\mu \mathrm{s}$ |
|  |  | StepBIkTime = '10' | 1.5 | 2.25 | 3 | $\mu \mathrm{s}$ |
|  |  | StepBIkTime = '11' | 3 | 4.25 | 5.5 | $\mu \mathrm{s}$ |
| Synchronous buck regulator (bridge 3) |  |  |  |  |  |  |
| $\mathrm{V}_{\text {AUX_SW }}$ | Output pin voltage range (DC3x) | (26) | -1 |  | $\mathrm{V}_{\text {Supply }}$ | V |
| $\mathrm{I}_{\mathrm{Q}}$ | Output leakage current | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C}$ | -50 |  | +50 | $\mu \mathrm{A}$ |
| $\mathrm{l}_{\text {QLP }}$ | Output leakage current in "Low Power Mode" | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V} \\ & \mathrm{~T}_{\text {junction }}=125^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | -10 |  | +10 | $\mu \mathrm{A}$ |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {FBREF }}$ | Synchronous buck regulator feedback reference voltage | SelFBRef = '00' | 0.776 | 0.8 | 0.824 | V |
|  |  | SelFBRef = '01' ${ }^{(21)}$ | 0.97 | 1 | 1.03 | V |
|  |  | SelFBRef = '10' ${ }^{(22)}$ | 2.425 | 2.5 | 2.575 | V |
|  |  | SelFBRef = '11' | 2.91 | 3 | 3.09 | V |
| IGPIO_FB | GPIO feedback pin current | $\begin{aligned} & \mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C} \\ & 0 \mathrm{~V} \leq \text { Feedback } \leq 3 \mathrm{~V} \end{aligned}$ | -15 |  | 15 | $\mu \mathrm{A}$ |
| $V_{\text {out }}$ | Output voltage range | $\mathrm{V}_{\text {Supply }}=36 \mathrm{~V}^{(23)}$ | 0.8 |  | 30 | V |
| $\mathrm{l}_{\text {load }}$ | Output load current | $\mathrm{V}_{\text {Supply }}=36 \mathrm{~V}$ | 0.002 |  | 1.5 | A |
| $\mathrm{R}_{\text {DSonHS }}$ | Internal high/low side $\mathrm{R}_{\text {DSon }}$ | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C} ; \mathrm{I}_{\text {load }}=1 \mathrm{~A}$ |  | 0.6 | 0.8 | $\Omega$ |
| $V_{\text {Ioop }}$ | Loop voltage accuracy |  |  | $\pm 3 \%$ | ) |  |
| $\mathrm{V}_{\text {REG_UV_f }}$ | Under voltage falling threshold | (24) | 84.5 | 87 | 89.5 | \% |
| $V_{\text {REG_UV_r }}$ | Under voltage rising threshold | (24) | 90.5 | 93 | 95.5 | \% |
| $\mathrm{V}_{\text {REG_UV_hys }}$ | Under voltage hysteresis |  | - | 6 |  | \% |
| $t_{\text {aux_UV }}$ | Under voltage deglitch filter | $\bigcirc$ |  | 5 |  | $\mu \mathrm{s}$ |
| $\mathrm{l}_{\text {limit }}$ | Current limit protection | $\square$ | 1.6 |  | 2.5 | A |
| $\mathrm{t}_{\text {deglitch }}$ | Current limit deglitch time | $\bigcirc$ | 50 |  |  | ns |
| t_lim | Current limit response time | Normal operating mode (no UV) ${ }^{(11)}$ |  | 480 | 700 | ns |
| tı_limuv | Current limit response time in UV condition. | UV condition ${ }^{(12)}$ |  | 350 | 500 | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Switching output rise time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=422 \Omega^{(25)} \end{aligned}$ | 5 |  | 30 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Switching output fall time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=10 \Omega \end{aligned}$ | 10 |  | 50 | ns |
| $\mathrm{t}_{\text {dead }}$ | Crossover dead time |  |  | 100 |  | ns |
| FREGPWM | Operating frequency |  |  | $\mathrm{F}_{\text {osc }} / 64$ |  | kHz |

Battery charger (Bridge 4)

| V ${ }_{\text {AUX3_SW }}$ | Output pin voltage range (DC4x) | (26) | -1 |  | $\mathrm{V}_{\text {Supply }}$ | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{Q}}$ | Output leakage current | $\mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C}$ | -100 |  | +100 | $\mu \mathrm{A}$ |
| $V_{\text {FBRef }}$ | Battery charger control loop feedback reference voltage | SelFBRef = '00' | 1.37 | 1.412 | 1.455 | V |
|  |  | SelFBRef $=$ '01' ${ }^{(8)}$ | 1.746 | 1.8 | 1.854 | V |
|  |  | SelFBRef = '10' | 2.079 | 2.143 | 2.207 | V |
|  |  | SelFBRef = '11' | 2.425 | 2.5 | 2.575 | V |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CurrRef }}$ | Battery charger control loop feedback reference current | SelCurrRef $=$ '00' ${ }^{(8)}$ | 0.873 | 0.9 | 0.927 | V |
|  |  | SelCurrRef = '01' | 1.394 | 1.437 | 1.48 | V |
|  |  | SelCurrRef = '10' | 1.746 | 1.8 | 1.854 | V |
|  |  | SelCurrRef = '11' | 2.182 | 2.25 | 2.318 | V |
| $V_{\text {out }}$ | Output voltage range | $\mathrm{V}_{\text {Supply }}=36 \mathrm{~V}{ }^{(27)}$ | 1.412 |  | 30 | V |
| $\mathrm{I}_{\text {load }}$ | Output load current | $V_{\text {Supply }}=36 \mathrm{~V}$ | 0.002 |  | 3 | A |
| $\mathrm{R}_{\text {DSon }}$ | Internal high/low side $\mathrm{R}_{\text {DSon }}$ | $\begin{aligned} & \mathrm{T}_{\text {junction }}=125^{\circ} \mathrm{C} ; \\ & \mathrm{I}_{\text {LOAD }}=1.5 \mathrm{~A} \end{aligned}$ |  | 0.3 | 0.4 | $\Omega$ |
| $V_{\text {loop }}$ | Loop voltage accuracy |  |  | $\pm 3 \%$ | $\times$ |  |
| $\mathrm{V}_{\text {BC_UV_f }}$ | Under voltage falling threshold | (28) | 84.5 | 87 | 89.5 | \% |
| $V_{B C}$ _UV_r | Under voltage rising threshold | (28) | 90.5 | 93 | 95.5 | \% |
| $\mathrm{V}_{\text {BC_UV_hys }}$ | Under voltage hysteresis |  |  | 6 |  | \% |
| $\mathrm{taux}_{\text {a }}$ UV | Under voltage deglitch filter |  | , | 5 |  | $\mu \mathrm{s}$ |
| $I_{\text {limit }}$ | Current limit protection |  | 3.2 |  | 5 | A |
| $t_{\text {deglitch }}$ | Current limit deglitch time |  | 50 |  |  | ns |
| t_lim | Current limit response time | Normal operating mode $(\text { no UV })^{(11)}$ |  | 480 | 700 | ns |
| t_limuV | Current limit response time in UV condition. | UV condition ${ }^{(12)}$ |  | 350 | 500 | ns |
| $\mathrm{t}_{\mathrm{r}}$ | Switching output rise time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=422 \Omega \end{aligned}$ | 5 |  | 30 | ns |
| $\mathrm{t}_{\mathrm{f}}$ | Switching output fall time | $\begin{aligned} & \mathrm{V}_{\text {Supply }}=36 \mathrm{~V}, \\ & \mathrm{R}_{\text {LOAD }}=10 \Omega \end{aligned}$ | 10 |  | 50 | ns |
| $\mathrm{t}_{\text {dead }}$ | Crossover dead time |  |  | 100 |  | ns |
| $\mathrm{F}_{\text {BCPWM }}$ | Operating frequency |  |  | $\mathrm{F}_{\text {osc }} / 64$ |  | kHz |

## ADC with A2DType $=0{ }^{(29)}$

| IMR | Measurement range | A2dType $=0$ | 0 |  | $V_{3 v 3}$ | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| INL | Integral non-linearity | A2dType $=0^{(30)(31)}$ |  |  | $\pm 2$ | LSB |
| DNL | Differential non-linearity | A2dType $=0^{(32)(31)}$ |  |  | $\pm 2$ | LSB |
| OE | Offset error | A2dType $=0^{(33)}$ |  |  | $\pm 4$ | LSB |
| OE $_{\text {Drift }}$ | Offset error drift | A2dType $=0$ over time <br> and temperature |  |  | $\pm 3$ | LSB |
| GE | Gain error | A2dType $=0^{(34)}$ |  |  | $\pm 4$ | LSB |
| GE $_{\text {Drift }}$ | Gain error drift | A2dType $=0$ over time <br> and temperature |  |  | $\pm 4$ | LSB |
| $\mathrm{t}_{\text {conv }}$ | Minimum conversion time |  |  |  | 55 | $\mu \mathrm{~s}$ |
|  | Resolution | (35) | 8 |  | bits |  |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {in }}$ | Input sampling capacitance | $(36)$ |  |  | 4 | pF |

ADC with A2DType=1 ${ }^{(37)}$

| IMR | Measurement range | A2dType $=1$ | 0 |  | $V_{3 v 3}$ | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| INL | Integral non-linearity | A2dType $=1{ }^{(30)(31)}$ |  |  | $\pm 1$ | LSB |
| DNL | Differential Non-Linearity | A2dType $=1{ }^{(32)(31)}$ |  |  | $\pm 1$ | LSB |
| OE | Offset error | A2dType $=1{ }^{\text {(33) }}$ |  |  | $\pm 4$ | LSB |
| $O E_{\text {Drift }}$ | Offset error drift | A2dType = 1 over time and temperature |  |  | $\pm 3$ | LSB |
| GE | Gain error | A2dType $=1{ }^{(34)}$ |  |  | $\pm 4$ | LSB |
| GE ${ }_{\text {Dritt }}$ | Gain error drift | A2dType = 1 over time and temperature |  |  | $\pm 4$ | LSB |
| $\mathrm{t}_{\text {conv }}$ | Minimum conversion time |  |  |  | 10 | $\mu \mathrm{s}$ |
|  | Resolution |  |  | 9 |  | bits |
| $\mathrm{C}_{\text {in }}$ | Input sampling capacitance | (36) |  |  | 4 | pF |

## Current DAC

| $\mathrm{V}_{\mathrm{R}}$ | Pin voltage operative range (GPIO8) | (38) | 0.7 |  | 5.5 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Iout_OFF | Output off leakage current | DacValue[5:0] $=000000$ | -1 |  | +1 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {FULL_ERR }}$ | Full scale current error | $\begin{aligned} & \text { DacRange }[1: 0]=x x \\ & \text { DacValue }[5: 0]=111111 \end{aligned}$ | -15 |  | +15 | $\begin{gathered} \% \text { of } \\ \mathrm{I}_{\text {FULL }} \\ \text { typ } \end{gathered}$ |
| $\mathrm{INL}{ }_{10 \_11}$ | Integral non-linearity for 10 and 11 ranges |  |  |  | $\pm 2$ | LSB |
| DNL ${ }_{10}$ _11 | Differential non-linearity for 10 and 11 ranges |  |  |  | $\pm 2$ | LSB |
| $\mathrm{INL}_{01}$ | Integral non-linearity for 01 range |  |  |  | $\pm 1$ | LSB |
| $\mathrm{DNL}_{01}$ | Differential non-linearity for 01 range |  |  |  | $\pm 1$ | LSB |
| $\mathrm{R}_{\text {CurrDac_res }}$ | Gpio[8] divider total resistance |  |  | 45 |  | k $\Omega$ |
| $\mathrm{R}_{\text {CurrDac_ratio }}$ | Gpio[8] divider ratio |  |  | 3/5 |  |  |
| $\mathrm{t}_{\text {set }}$ | Settling time | (39) |  |  | 5 | $\mu \mathrm{s}$ |

Operational amplifier ${ }^{(40)}$

| $\mathrm{V}_{\text {GPIO_SPI }}$ | Operational amplifier supply <br> voltage range |  | 3.15 | 3.3 | 3.45 |
| :---: | :--- | :--- | :---: | :---: | :---: |
| $\mathrm{~V}_{\text {ICM }}$ | Input common mode voltage <br> range |  | 0 |  | $\mathrm{V}_{\text {GPIO_ }}$ <br> SPI |
| $\mathrm{V}_{\text {OUT_MAX }}$ | Output voltage | V |  |  |  |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VOp1PlusRef VOp2PlusRef | Operational amplifier 1 and 2 reference voltage | OpxRef[1:0]=00 <br> OpxRef[1:0]=01 <br> OpxRef[1:0]=10 <br> OpxRef[1:0]=11 | $\begin{gathered} 0.97 \\ 1.6 \\ 1.94 \\ 2.425 \end{gathered}$ | $\begin{gathered} 1 \\ 1.65 \\ 2 \\ 2.5 \end{gathered}$ | $\begin{gathered} 1.03 \\ 1.7 \\ 2.06 \\ 2.575 \end{gathered}$ | V |
| Avd | Open loop gain | $\begin{aligned} & \mathrm{V}_{\text {ICM }}=1.65 \mathrm{~V} \\ & \mathrm{I}_{\text {LOAD }}=0 \mathrm{~mA} \end{aligned}$ | 90 |  |  | dB |
| CMRR | Common mode rejection ratio |  | 80 | 110 |  | dB |
| PSRR | Power supply rejection ratio | $\begin{aligned} & \mathrm{I}_{\mathrm{LOAD}}= \pm 6 \mathrm{~mA} \\ & \mathrm{~V}_{\text {ICM }}=1.65 \mathrm{~V} \end{aligned}$ |  | 90 |  | dB |
| $\mathrm{I}_{\text {in _offs }}$ | Input offset current |  | -150 |  | 150 | nA |
| $\mathrm{I}_{\text {in _ bias }}$ | Input bias current |  | -500 |  | 500 | nA |
| $\mathrm{V}_{\text {in _offs }}$ | Input offset voltage |  | -5 |  | 5 | mV |
| GBWP | Gain bandwidth product | $\begin{aligned} & \mathrm{C}_{\text {load }}=100 \mathrm{pF} \mathrm{~V}_{\text {ICM }}=1.65 \mathrm{~V} \\ & \mathrm{R}_{\text {load }}=330 \Omega \text { to } \mathrm{V}_{\text {GPIO_SPI }} \end{aligned}$ | $2$ |  |  | MHz |
| $\mathrm{I}_{\text {out }}$ | Output current | $\mathrm{V}_{\text {out }}=1.65 \mathrm{~V}$ |  |  | 10 | mA |
| $\mathrm{I}_{\text {short_max }}$ | Short circuit current |  | 12 | 20 |  | mA |
| SR | Slew rate | $\begin{aligned} & \mathrm{l}_{\text {load }}=0 \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF} \end{aligned}$ | 1.3 | 1.75 |  | V/ $/ \mathrm{s}$ |

Operational amplifier used as comparator (40) (41)

| Vout_max | Output voltage | $\mathrm{I}_{\text {load }}= \pm 10 \mathrm{~mA}$ | 0.3 |  | 2.9 | V |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {OFF }}$ | Turn off propagation delay | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=1.65 \mathrm{~V} \\ & \Delta \mathrm{Vi}=-/+20 \mathrm{mV} \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF}{ }^{(42)(43)} \\ & \hline \end{aligned}$ |  | 0.6 | 1 | $\mu \mathrm{S}$ |
| $t_{\text {FALL }}$ | Fall time | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=1.65 \mathrm{~V} \\ & \Delta \mathrm{Vi}=-/+20 \mathrm{mV} \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF}{ }^{(42)(43)} \end{aligned}$ |  | 0.15 | 0.4 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{\mathrm{ON}}$ | Turn on propagation delay | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=1.65 \mathrm{~V} \\ & \Delta \mathrm{Vi}=-/+20 \mathrm{mV} \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF}{ }^{(42)(43)} \end{aligned}$ |  | 0.25 | 0.5 | $\mu \mathrm{S}$ |
| $t_{\text {RISE }}$ | Rise time | $\begin{aligned} & \mathrm{V}_{\mathrm{CM}}=1.65 \mathrm{~V} \\ & \Delta \mathrm{Vi}=-/+20 \mathrm{mV} \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF}{ }^{(42)(43)} \end{aligned}$ |  | 0.2 | 0.4 | $\mu \mathrm{S}$ |
| Low power switch |  |  |  |  |  |  |
| $\mathrm{V}_{\text {PSW }}$ | Input voltage range |  | 2.4 |  | 3.6 | V |
| Vout_max | Output voltage |  |  |  | $\begin{gathered} \mathrm{V}_{\mathrm{GPIO}} \\ \mathrm{SPI} \end{gathered}$ | V |
| $\mathrm{R}_{\text {DSon }}$ | Switch $\mathrm{R}_{\text {DSon }}$ resistance | $\mathrm{I}_{\text {load }}=100 \mathrm{~mA}$ |  | 0.6 | 1 | $\Omega$ |
| ILIMIT | Current limit |  | 150 | 250 | 350 | mA |
| $\mathrm{t}_{\text {deglitch }}$ | Current limit deglitch time |  | 50 |  |  | ns |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {I_lim }}$ | Current limit response time |  |  |  | 650 | ns |
| $\mathrm{C}_{\text {LOAD }}$ | Max load capacitance |  |  |  | 2.5 | $\mu \mathrm{F}$ |
| $\mathrm{t}_{\mathrm{ON}}$ | Turn on propagation delay | $\begin{aligned} & \mathrm{V}_{\text {GPIO_SPI }}=3.3 \mathrm{~V} \mathrm{I}_{\text {LOAD }}=1 \mathrm{~mA} \\ & \mathrm{C}_{\text {LOAD }}=100 \mathrm{pF}\left({ }^{(44)}\right. \end{aligned}$ |  | 450 | 650 | ns |
| $t_{\text {OFF }}$ | Turn off propagation delay | $\begin{aligned} & \mathrm{V}_{\mathrm{GPIO} \text { SPI }}=3.3 \mathrm{~V} \\ & \mathrm{l}_{\mathrm{LOAD}}=1 \mathrm{~mA} \\ & \mathrm{C}_{\mathrm{LOAD}}=100 \mathrm{pF}^{(44)} \end{aligned}$ |  | 250 | 450 | ns |
| Interrupt controller |  |  |  |  |  |  |
| $\mathrm{t}_{\text {PULSE }}$ | Pulse duration |  |  | $16 * \mathrm{~T}_{\text {osc }}$ |  | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\text {INTFILT }}$ | Filter time |  |  | 200 |  | ns |

GPIO[0], GPIO[1], GPIO[2], GPIO[3], GPIO[4], GPIO[6]

| $\mathrm{V}_{\mathrm{IH}}$ | High level input voltage |  | 1.6 |  |  | V |
| :---: | :--- | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low level input voltage |  |  |  | 0.8 | V |
| $\mathrm{~V}_{\mathrm{HYS}}$ | Input voltage hysteresis |  | 0.15 | 0.22 |  | V |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low level output voltage | $\mathrm{l}_{\text {OUT }}=15 \mathrm{~mA}$ |  |  | 0.5 | V |
| $\mathrm{I}_{\text {LEAKAGE }}$ | Leakage current | $0 \leq \mathrm{V}_{\text {out }} \leq \mathrm{V}_{3 \mathrm{v3}}$ | -1 |  | 1 | $\mu \mathrm{~A}$ |
| $\mathrm{t}_{\text {DELAY }}$ | Delay from serial write to pin <br> Low | $\mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}^{(45)}$ |  |  | 500 | ns |

GPIO[5], GPIO[7], GPIO[9], GPIO[10], GPIO[11], GPIO[12], GPIO[13], GPIO[14]

| $\mathrm{V}_{\mathrm{IH}}$ | High level input voltage |  | 1.6 |  |  | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low level input voltage |  |  |  | 0.8 | V |
| $\mathrm{~V}_{\mathrm{HYS}}$ | Input voltage hysteresis |  | 0.15 | 0.22 |  | V |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low level output voltage | $\mathrm{I}_{\text {OUT }}=15 \mathrm{~mA}$ |  |  | 0.5 | V |
| $\mathrm{~V}_{\text {OH }}$ | High level output voltage | $\mathrm{l}_{\text {OUT }}=5 \mathrm{~mA}$ | 2.75 |  |  | V |
| $\mathrm{I}_{\text {LEAKAGE }}$ | Leakage current | $0 \leq \mathrm{V}_{\text {out }} \leq \mathrm{V}_{3 \mathrm{~V} 3}$ | -1 |  | 1 | $\mu \mathrm{~A}$ |
| $\mathrm{t}_{\text {DELAY }}$ | Delay from serial write to pin <br> low | $\mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}^{(45)}$ |  |  | 500 | ns |

GPIO[8]

| $\mathrm{V}_{\mathrm{IH}}$ | High level input voltage |  | 1.6 |  |  | V |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{~V}_{\mathrm{IL}}$ | Low level input voltage |  |  |  | 0.8 | V |
| $\mathrm{~V}_{\mathrm{HYS}}$ | Input voltage hysteresis |  | 0.13 | 0.22 |  | V |
| $\mathrm{~V}_{\mathrm{OL}}$ | Low level output voltage | IOUT $=15 \mathrm{~mA}$, |  | 0.4 | V |  |
| $\mathrm{I}_{\text {LEAK_0 }}$ | Leakage current | EnGpio8Digln=0, <br> $0 \leq$ Vout $\leq 5 \mathrm{~V}$ | -1 |  | 1 | $\mu \mathrm{~A}$ |
| $\mathrm{I}_{\text {LEAK_1 }}$ | Leakage current | EnGpio8Digln=1, <br> $0 \leq$ Vout $\leq 5 \mathrm{~V}$ | -1 |  | 5 | $\mu \mathrm{~A}$ |

Table 5. Electrical characteristics (continued)

| Parameter | Description | Test condition | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {AD }}$ | A/D path absorbed current | $\begin{aligned} & \text { ADChanneIX[4:0] } \\ & =10001 \text { and } \\ & \text { bit EnDacScale=0 } \end{aligned}$ | -1 |  | 1 | $\mu \mathrm{A}$ |
| $t_{\text {deLay }}$ | Delay from serial write to pin Iow | $C_{\text {LOAD }}=50 \mathrm{pF}^{(45)}$ |  |  | 500 | ns |
| SPI interface ${ }^{(40)}$ |  |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ | High level input voltage | (46) | 1.6 |  |  | V |
| $\mathrm{V}_{\text {IL }}$ | Low level input voltage | (46) |  |  | 0.8 | V |
| $\mathrm{V}_{\mathrm{HYS}}$ | Input voltage hysteresis | (46) | 0.15 | 0.22 |  | V |
| $\mathrm{V}_{\mathrm{OH}}$ | High level output voltage | $\mathrm{I}_{\text {OUT }}=-10 \mathrm{~mA},{ }^{(47)}$ | 2.75 |  | 1 | V |
| $\mathrm{V}_{\mathrm{OL}}$ | Low level output voltage | $\mathrm{I}_{\text {OUT }}=10 \mathrm{~mA},{ }^{(47)}$ |  |  | 0.4 | V |
| $\mathrm{t}_{\text {SCLK }}$ | SCLK period |  | 62.5 |  |  | ns |
| tsCLK_rise | SCLK rise time |  | , |  | 2 | ns |
| tsCLK_fall | SCLK fall time |  |  |  | 2 | ns |
| ${ }_{\text {t }}^{\text {SCLK_high }}$ | SCLK high time |  | 20 |  |  | ns |
| tsCLK_Iow | SCLK low time |  | 20 |  |  | ns |
| $\mathrm{t}_{\text {nSS_setup }}$ | nSS setup time |  | 10 |  |  | ns |
| $t_{\text {nSS_hold }}$ | nSS hold time | $\square$ | 10 |  |  | ns |
| $t_{\text {nSS_min }}$ | nSS high minimum time |  | 30 |  |  | ns |
| $\mathrm{t}_{\text {MOSI_setup }}$ | MOSI setup time |  | 10 |  |  | ns |
| ${ }^{\text {m MOSI_hold }}$ | MOSI hold time |  | 10 |  |  | ns |
| $\mathrm{t}_{\text {MISO_rise }}$ | MISO rise time | $\mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}{ }^{(48)}$ |  |  | 9 | ns |
| $\mathrm{t}_{\text {MISO_fall }}$ | MISO fall time | $\mathrm{C}_{\text {LOAD }}=50 \mathrm{pF}{ }^{(48)}$ |  |  | 9 | ns |
| $\mathrm{t}_{\text {MISO_valid }}$ | MISO valid from clock low |  | 0 |  | 15 | ns |
| $\mathrm{t}_{\text {MISO_disable }}$ | MISO disable time |  | 0 |  | 15 | ns |
| $\mathrm{C}_{\text {LOAD }}$ | MOSI maximum load |  |  |  | 200 | pF |

1. This value is useful to define the voltage rating for external capacitor to be connected from $\mathrm{V}_{\text {Supply }}$ to $\mathrm{V}_{\text {Supplylint }}$.
2. This typical value is only intended to give an estimation of the current consumption when L6460 is configured in simple regulators mode (see following Chapter 8.6.4) at the end of the start up sequence and with no load on regulators. This typical value allows a raw choose of the external resistor but the definitive choose must be done according to the recommendations on Chapter 4.1).
3. Measured between $10 \%$ and $90 \%$ of output voltage transition.
4. Measured from a fault detection to $50 \%$ of output voltage transition.
5. Current is defined to be positive when flowing into the pin.
6. Load regulation is calculated at a fixed junction temperature using short load pulses covering all the load current range. This is to avoid change on output voltage due to heating effect.
7. Undervoltage rising and falling thresholds are intended as a percentage of feedback pin voltage ( $\mathrm{V}_{\text {LINmain_FB }}$ ).
8. Default state.
9. The regulated voltage can be calculated using the formula: $\mathrm{V}_{\text {SWmain_OUT }}=\mathrm{V}_{\text {FBREF }}{ }^{*}\left(\mathrm{R}_{\mathrm{a}}+\mathrm{R}_{\mathrm{b}}\right) / \mathrm{R}_{\mathrm{b}}$.
10. Undervoltage rising and falling thresholds are intended as a percentage of feedback pin voltage ( $\mathrm{V}_{\mathrm{SW} \text { _main_FB }}$ ).
11. This condition is intended to simulate an extra current on output.
12. This condition is intended to simulate a short circuit on output.
13. Rise and fall time are measured between $10 \%$ and $90 \% \mathrm{~V}_{\text {SWmain }}$ output voltage.
14. Undervoltage rising and falling thresholds are intended as a percentage of feedback pin voltage ( $\mathrm{V}_{\text {SWDRV_FB }}$ ).
15. The current protection values must be intended as a protection for the chip and not as a continuous current limitation. The protection is performed by switching off the output bridge when current reaches values higher than the $\mathrm{I}_{\mathrm{Oc}} \mathrm{max}$. No protection could be guaranteed for values in the middle range between $\mathrm{I}_{\mathrm{MAX}}$ and $\mathrm{I}_{\mathrm{OC}}$
16. In this cell $X$ stands for 1 or $2, Y$ stands for $A$ or $B$
17. In this cell $X$ stands for 3 or $4, Y$ stands for $A$ or $B$
18. The current protection thresholds for Bridge 3 and 4 are not selectable so only the max current value (MtrXSideYILimSel[1:0]= 11) is available.
19. Overcurrent Off time can be configured using SPI.
20. Rise and fall time are measured between $10 \%$ and $90 \%$ of DC output voltage. With device in full bridge configuration (resistive load between outputs).
21. Default state for Aux1
22. Default state for Aux2
23. The regulated voltage can be calculated using the formula: $V_{A U X}$ _sw $=V_{\text {FBREF }}{ }^{*}\left(R_{a}+R_{b}\right) / R_{b}$.
24. Undervoltage rising and falling thresholds are intended as a percentage of feedback pin voltage (GPIO1 and/or GPIO2)
25. Rise and fall time is measured between $10 \%$ and $90 \%$ of output voltage.
26. The external components connected to the pin must be chosen to avoid that the voltage exceeds this operative range.
27. The regulated voltage can be calculated using the formula: $V_{A U X 3}$ SW $=V_{F B R E F} *\left(R_{a}+R_{b}\right) / R_{b}$.
28. Undervoltage rising and falling thresholds are intended as a percentage of feedback pin voltage ( $\mathrm{V}_{\mathrm{REF}}$ _FB).
29. The definition of LSB for this table is LSB=IMRmax/(2 $2^{7.5}-1$ ).
30. Integral Non Linearity error (INL) is defined as the maximum distance between any point of the ADC characteristic and the "best straight line" approximating the ADC transfer curve.
31. The ADC ensures monotonic characteristic and no missing codes.
32. Differential nonlinearity error (DNL) is defined as the difference between an actual step width and the ideal width value of 1 LSB.
33. Offset error (OE) is the deviation of the first code transition ( $000 \ldots 000$ to $000 \ldots 001$ ) from the ideal (i.e. GND + 0.5 LSB).
34. Gain error (GE) is the deviation of the last code transition (111... 110 to 111...111) from the ideal (V3v3-0.5 LSB), after adjusting for offset error.
35. Please note that the result of the conversion will always be a 9-bit word: to speed up the conversion, the resolution is reduced when the ADC is used in the 8 -bit resolution mode.
36. Actual input capacitance depends on the pin that must be converted.
37. The definition of LSB for this table is LSB=IMRmax/( $\left.2^{9}-1\right)$.
38. All parameters are guaranteed in the range between $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{V}_{\mathrm{R} \text { Max }}$.
39. Measured from DacValue[5:0] change in SPI interface.
40. $\mathrm{V}_{\text {GPIO_SPI }}=3.3 \mathrm{~V}$ unless otherwise specified
41. In this section reports the operational amplifier parameters that change when used as comparator.
42. $\Delta \mathrm{Vi}$ is the differential voltage applied to input pins across the common voltage $\mathrm{V}_{\mathrm{CM}}$.
43. Measured between $50 \%$ of input and output signal.
44. Time measured from change in SPI interface to $50 \%$ of external pin transition.
45. Measured between nSS rising edge and $50 \%$ of $\mathrm{V}_{\text {out }}$ -
46. Specification applies to nSS, SCLK and MOSI pins.
47. Current is considered to be positive when flowing towards the IC
48. These times are measured at the pin output between specified $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$.

## 4 Internal supplies

L6460 includes three internal regulators used to provide a regulated voltage to internal circuits.

The internal regulators are the following:

- $\mathrm{V}_{\text {SupplyInt }}$ regulator.
- Charge pump regulator.
- $\mathrm{V}_{3 \mathrm{v} 3}$ regulator.


## 4.1 $\quad V_{\text {Supplylnt }}$ regulator

$\mathrm{V}_{\text {Supplyint }}$ is the output of an internal regulator used to supply some internal circuits. This regulator is not intended to provide external current so it must not be used to supply external loads. An external capacitor must always be connected to this pin (preferably towards $\mathrm{V}_{\text {Supply }}$ pin), recommended value is in the range $80 \div 120 \mathrm{nF}$.

Figure 3. $\quad \mathbf{V}_{\text {SupplyInt }} \mathbf{p i n}$


The $\mathrm{V}_{\text {Supplyint }}$ pin may also be externally connected to $\mathrm{V}_{\text {Supply }}$ pin by means of an external resistor $\mathrm{R}_{\text {EXT }}$ : this allows $\mathrm{R}_{\text {EXT }}$, particularly when $\mathrm{V}_{\text {Supply }}$ is at the max values of the operative supply range, to dissipate power that otherwise would be dissipated inside the chip. The choice of the optimal resistor depends on the application since it is strictly depending on both $\mathrm{V}_{\text {Supply }}$ and the current used inside the chip (that is changing with the chosen configuration).

$I_{S_{\_n n}} \max$ is depending from the chosen configuration and represents the total current needed by the circuits connected to this pin.

For example, with $\mathrm{V}_{\text {supply }}=32 \mathrm{~V}$ and $\mathrm{I}_{\mathrm{S} \_ \text {Int }}=12 \mathrm{~mA}$ a typical resistor value is $1 \mathrm{k} \Omega$.

### 4.2 Charge pump regulator

L6460 implements a charge pump regulator to generate a voltage over $\mathrm{V}_{\text {Supply }}$.This voltage is used to drive internal circuits and the external FET driver and cannot be used for any other purpose.

This circuit is always under the supervisory circuit control, so no regulator can start before the $\mathrm{V}_{\text {Pump }}$ voltage reaches its undervoltage rising threshold. If $\mathrm{V}_{\text {Pump }}$ voltage falls down below its under voltage falling threshold, all the regulators will be switched off.

The charge pump circuit is disabled when L6460 is in "low power mode".
Figure 4. Charge pump block diagram


An example of capacitors value is: $\mathrm{C}_{\mathrm{FLY}}=100 \mathrm{nF}$ and $\mathrm{C}_{\text {вооят }}=1 \mu \mathrm{~F}$

### 4.3 V3v3 regulator

V3v3 is the output of an internal regulator used to supply some low voltage internal circuits. This regulator is not intended to provide external current so it must not be used to supply external loads. An external capacitor must always be connected from this pin to GND, recommended value is in the range $80 \div 120 \mathrm{nF}$.

## 5 Supervisory system

The supervisory circuitry monitors the state of several functions inside L6460 and resets the device (and other ICs if connected to nRESET pin) when the monitored functions are outside their normal range. Supervisory circuitry can be divided into three main blocks:

- Power on reset (POR) generation circuitry.
- nRESET (nRST_int) generation circuitry.
- Thermal shut down (TSD) generation circuitry.

POR circuitry monitors the voltages that L6460 needs to guarantee its own functionality; nRESET circuitry controls if L6460's main voltages are inside the normal range; TSD is the thermal shut down of the chip in case of overheating.

### 5.1 Power on reset (POR) circuit

Power on reset circuit monitors $\mathrm{V}_{\text {Supply, }}$, and $\mathrm{V}_{3 \mathrm{~V} 3}$ voltages. The purpose of this circuit is to set the device is in a stable and controlled status until the minimum supply voltages that guarantee the device functionality are reached. The output signal of this circuit (in the following indicated as "POR") becomes active when $\mathrm{V}_{\text {Supply }}$ or $\mathrm{V}_{3 \mathrm{~V} 3}$ go under their falling threshold.

When POR output signal is active, all functions and all flags inside L6460 are set in their reset state; once POR signal comes back from off state (meaning monitored voltages are above their rising threshold), the power up sequence is re-initialized.

## 5.2 nRESET generation circuit

The nRESET circuit monitors $\mathrm{V}_{\text {Supply, }}, \mathrm{V}_{\text {Supplylnt }}, \mathrm{V}_{\text {Pump }}, \mathrm{V}_{\mathrm{GPIO} \text { SPI }}$ and all system regulators $\left(\mathrm{V}_{\text {System }}\right)$ voltages. The purpose of this circuit is to prevent the device functionality until the monitored voltages reach their operative value (please note that $\mathrm{V}_{3 \mathrm{v} 3}$ is monitored by POR, so it must be above its minimum value, otherwise nRESET circuit is not active).

This circuit generates an internal reset signal (in the following indicated as "nRST_int") that will also be signaled to external circuits by pulling low the nRESET pin.

The signal nRST_int becomes active in the following cases:

1. When one of the following voltages is lower than its own under voltage threshold:

- $\mathrm{V}_{\text {Supply }}$ and $\mathrm{V}_{\text {SupplyInt }}$.
- $V_{\text {Pump }}$.
- $\quad \mathrm{V}_{\text {System }}$ (all switching or linear system regulators voltages).
- $\mathrm{V}_{\text {GPIO_SPI }}$.

2. When watchdog timer counter (see Chapter 6) elapse the watchdog timeout time (only if watchdog function is enabled).
3. When L6460 is in "Low Power mode".
4. When EnExtSoftRst bit in SoftResReg register is at logic level = " 1 " and a "SoftRes" command is applied (see SoftResReg register description in Chapter 25).

When an nRST_int event is caused by above cases, the nRESET pin will stay low for a
"stretch" time that starts from the moment that nRST_int signal returns in the operative
state. This stretch time can be selected by setting the ID[1:0] bits in the SampleID register according to following table.

Table 6. Stretch time selection

| ID[1] | ID[0] | Selected stretch time | Note |
| :---: | :---: | :---: | :---: |
|  |  | Typ |  |
| 0 | 0 | 16 ms | Default state |
| 0 | 1 | 32 ms |  |
| 1 | 0 | 48 ms |  |
| 1 | 1 | 64 ms |  |

When nRST_int becomes active (logic level $=$ " 0 ") it sets in their reset state some of the functions inside L6460. The main functions that will be reset by nRST_int signal are the following:

- Serial interface will be reset and will not accept any other command.
- The bridges 1 and 2 will place their outputs in high impedance and PWM and direction signals will be reset.
- AD converter will be powered off.
- GPIOs will be powered off.
- Current DAC will be powered off.
- Operational amplifiers will be powered off.
- Watchdog count will be reset (while Watchdog flags won't be reset).
- Interrupt controller will be powered off.
- Digital comparator will be powered off.

Additionally the system regulators will be powered off but only if the voltage that caused the nRST_int event is checked before the system regulator in the power up sequence. This means that:
all system regulators will be powered off if $n R S T$ int is caused by $\mathrm{V}_{\text {Supply }}$,
$\mathrm{V}_{\text {SupplyInt }}, \mathrm{V}_{\text {Pump }}$ (and also if V3v3 causes a POR);

- no one of the system regulators will be powered off if nRST_int is caused by VGPIO_SPI;
- only the system regulators that follows the system regulator that caused the nRST_int in power up sequence will be powered off.

Figure 5. nReset generation circuit


Note: $\quad$ All regulator voltages included in power up sequence $\left(V_{S y s} X-V_{S y s Y}\right.$ in Figure 5) will be considered as nRESET circuit voltages.

### 5.3 Thermal shut down generation circuit

The third component of the supervisory circuit is the thermal shut down generation circuit.
This circuit generates two different flags depending on the IC temperature:

- the "TSD" flag indicates that the IC temperature is greater than the maximum allowable temperature.
- the "Warm" flag, that can be read using serial interface, becomes active at a lower temperature respect to TSD signal, therefore it can be used to prevent the IC from reaching over temperature.

When a TSD event occurs, L6460 will enter in the reset state placing the bridges in high impedance and turning off all regulators and other circuits until the internal temperature decreases below the Warm temperature. At this point, L6460 will restart the power up sequence and TSD bit will be set and will be readable as soon as L 6460 will come out from the reset state.

This TSD bit can be reset in three ways:

- by writing a logic level ' 1 ' in the ClearTSD bit in the ICTemp register (see Chapter 24);
- by a POR event;
- by entering in "Low Power Mode".

The Warm bit, set by L6460 when IC is working over the warming temperature, can be read using the SPI interface. Once this bit is set it can be reset in three ways:

- by writing a logic level ' 1 ' in the ClearWarm bit;
- by a POR event;
- by entering in "Low Power Mode".

The thermal sensor voltage can be converted using the internal $A / D$ : this way the microcontroller can directly measure the IC temperature.

To avoid unwanted commutation especially when temperature is near the thresholds, the output signal is filtered for both TSD and Warm.

## 6 Watchdog circuit

The Watchdog timer can be used to reset L6460 if it is not serviced by the firmware that can periodically write at logic level "1' the ClrWDog bit in the WatchDogStatus register.

This circuit is disabled by default; firmware can enable it by setting at logic level ' 1 ' the WDEnable bit in the WatchDogCfg register.

When the Watchdog timeout event happens, L6460 sets to '1' a latched bit WDTimeOut in theWatchDogStatus register that can be read using SPI interface; once this bit is set it can be cleared in three ways:

- by writing a ' 1 ' in the WDClear bit in the WatchDogStatus register.
- by writing a ' 1 ' in the SoftReset bit in the WatchDogStatus register.
- by a POR event.

The Watchdog function includes also a warning bit WDWarning to indicate, via serial interface or via the circuit called Interrupt Controller (see Chapter 21) that the watchdog is near to its timeout; this bit is asserted to logic level "1" exactly one watch dog clock period (WD_Tclk) before the watchdog timeout happens. Firmware can enable the WDTimeOut signal to cause an " $n$ Rst_int" event by setting to logic ' 1 ' the WDEnnRst bit.

Figure 6. Watchdog circuit block diagram


The watchdog timeout has an imprecision of maximum one WD_Tclk. The effective programmed WD time is changed in the register only when the watchdog circuit is serviced by firmware with CIrWDog bit. At this time the watchdog timer is reset and the new value of the WD delay value is loaded.

The watchdog timer can be programmed to generate different timeouts using the WDdelay[3:0] bits in the WatchDogCfg register according to following table.

Table 7. Watchdog timeout specifications

| WDdelay[3:0] | WD timeout |
| :---: | :---: |
|  | Typ |
| 0000 | $8^{*}$ WD_Tclk |
| 0001 | $9^{*}$ WD_Tclk |
| 0010 | $10^{*}$ WD_Tclk |
| 0011 | $11^{*}$ WD_Tclk |
| 0100 | $12^{*}$ WD_Tclk |
| 0101 | $13^{*}$ WD_Tclk |
| 0110 | $14^{*}$ WD_Tclk |
| 0111 | $15^{*}$ WD_Tclk |
| 1000 | $16^{*}$ WD_Tclk |
| 1001 | $17^{*}$ WD_Tclk |
| 1010 | $18^{*}$ WD_Tclk |
| 1011 | $19^{*}$ WD_Tclk |
| 1100 | $20^{*}$ WD_Tclk |
| 1101 | $21^{*}$ WD_Tclk |
| 1110 | $22^{*}$ WD_Tclk |
| 1111 | $23^{* W D \_T c l k}$ |

## 7 Internal clock oscillator

L6460 includes a free running oscillator that does not require any external components.
This circuit is used to generate the time base needed to generate the internal timings; the typical frequency is 16 MHz .

The oscillator circuit starts as soon as the IC exits from the power on reset condition and it is stopped only when in "low power mode".

## 8 Start-up configurations

L6460 start-up configuration is selected by setting in different states the GPIO[0], GPIO[3] and GPIO[4] pins. Each of these is a three state input pin and is able to distinguish among the following situations:

Table 8. Possible start-up pins state symbol

| Pin condition | State symbol |
| :---: | :---: |
| Shorted to ground | 0 |
| Shorted to $\mathrm{V}_{3}$ pin | 1 |
| Floating | Z |

Note: "Shorted" means: $R \leq 1$ KOhm; " $Z$ " means: $R \geq 10 K O h m, C \leq 200 p F$

### 8.1 Operation modes

When $\mathrm{V}_{\text {Supply }}$ voltage is applied to L6460, the internal regulator V 3 v 3 , used to supply the logic circuits inside the device, starts its functionality. When it reaches its final value, L6460 enables the GPIO[0] pin state read circuitry, and, after a time TpinSample, it will sample the GPIO[0] state. If it is found to be in high impedance, L6460 does not consider GPIO[3] and GPIO[4] pins state and starts its "Basic device" mode sequence. If GPIO[0] is found to be connected to ground or to V3v3, L6460 checks the state of GPIO[3] and GPIO[4] pins to select its start-up configuration.
The possible configurations can be classified in four "Major" modes:

1. Basic device.
2. Slave device.
3. Master device.
4. Single device.

Hereafter is reported the correspondence table between GPIO[X] state and L6460 configurations.

Table 9. Start-up correspondence

| Pin state ${ }^{(1)}$ |  |  | Major mode | Minor mode ${ }^{(2)}$ |
| :---: | :---: | :---: | :---: | :---: |
| GPIO[0] | GPIO[3] | GPIO[4] |  |  |
| Z | X | X | Basic |  |
| 0 | 0 | 0 | Single | Bridge |
| 0 | 0 | Z |  | Primary regulator |
| 0 | 0 | 1 |  | Regulators |
| 0 | Z | 0 |  | Simple regulator |
| 0 | Z | Z |  | Bridge + VEXT ${ }^{(3)}$ |
| 0 | Z | 1 |  | Secondary regulators |
| 0 | 1 | 0 | Master | Bridge |
| 0 | 1 | Z |  | Primary regulator |
| 0 | 1 | 1 |  | Regulators |
| 1 | 0 | 0 |  | Simple regulator |
| 1 | 0 | Z |  | Bridge + VEXT ${ }^{(3)}$ |
| 1 | 0 | 1 |  | Secondary regulators |
| 1 | Z | 0 | Slave | Bridge |
| 1 | Z | Z |  | Primary regulator |
| 1 | Z | 1 |  | Regulators |
| 1 | 1 | 0 |  | Simple regulator |
| 1 | 1 | Z |  | Bridge + VEXT ${ }^{(3)}$ |
| 1 | 1 | 1 |  | Secondary regulators. |

1. "X" means "don't care".
2. The description of these modes is in the following Chapter 8.6
3. VEXT is the regulator output voltage obtained using the switching regulator controller with external FET.

### 8.2 Basic device mode

The basic device mode is selected by leaving the GPIO[0] pin floating. In this mode L6460 doesn't use GPIO[3] and GPIO[4] as configuration pins, leaving them free for other uses.

When in this mode the regulators included in the start up sequence (except $\mathrm{V}_{\text {SWmain }}$ ) are considered as system regulators and they start in the following sequence:

1. Auxiliary switching regulator1 ( $\mathrm{V}_{\mathrm{AUX} 1}$ _SW $)$.
2. Auxiliary switching regulator2 ( $\mathrm{V}_{\mathrm{AUX}}$ _SW).
3. Main linear regulator $\left(\mathrm{V}_{\text {SWmain }}\right)$.
4. Main switching regulator $\left(\mathrm{V}_{\text {SWmain }}\right)$ (Not system regulator).

### 8.3 Slave device mode

In slave device mode, L6460 consider the nAWAKE pin as an input enable. Since this is now a digital pin, the current pull up source inside the nAWAKE circuit is disabled.

At the startup, if the nAWAKE pin is found to be low for a period higher than $t_{\text {AWAKEFILT }}$, L6460 enters directly in the "Low Power mode"; when nAWAKE pin is pulled high for a period higher than $t_{\text {AWAKEFILT, }}$ L6460 begins its start up procedure.

### 8.4 Master device mode

In master device mode, L6460 begins its start up procedure without waiting for any external enable signal and it uses GPIO[5] pin to drive the nAWAKE pin of Slave devices.

During the whole start up time, it forces its GPIO[5] pin at logic level "0" in order to maintain all slave devices in "Low Power mode" as previously described. When start up operations are completed, L6460 forces the GPIO[5] output to logic level "1" to enable the slave devices and keeps GPIO[5] output at high level until it senses an under-voltage on any of its System regulators. If firmware writes in the PwrCtrl register to set Master L6460 in "Low Power mode" it immediately forces GPIO[5] output to logic level "0" to force the slave devices to enter in "Low Power mode", then it waits for TMASTWAIT $^{\text {time }}$ and it starts its "Low Power mode" sequence.

### 8.5 Single device mode

In single device mode, the device behaves similarly to master device mode but:

1. It doesn't use the GPIO[5] pin to drive slave devices.
2. It doesn't wait for $T_{\text {MASTWAIT }}$ before entering in "Low Power mode".

### 8.6 Sub-configurations for slave, master or single device modes

Each slave, master or single device modes can be divided in other minor modes depending on the start-up sequence needed for L6460 internal regulators.

Unless otherwise specified, in all the following modes the regulators included in the start up sequence are considered system regulators and they start in the sequence indicated.

### 8.6.1 Bridge mode

In this configuration bridges 3 and 4 are not used as regulators and therefore can be configured by the firmware in any of their possible bridge modes.

When in this mode the power-up sequence is:

1. Main switching regulator $\left(\mathrm{V}_{\mathrm{SWmain}}\right)$.
2. Main linear regulator ( $\mathrm{V}_{\text {LINmain }}$ ).

### 8.6.2 Primary regulator mode (KP)

In this configuration bridge 4 can be configured by firmware while bridge 3 is configured as two separate synchronous switching regulators. The last regulator in the sequence ( $\mathrm{V}_{\text {AUX2_SW }}$ ) is not considered a system regulator.
When in this mode the power-up sequence is:

1. Auxiliary switching regulator1 $\left(\mathrm{V}_{\mathrm{AUX1}}\right.$ _SW $)$.
2. Main switching regulator $\left(\mathrm{V}_{\text {SWmain }}\right)$ together with main linear regulator $\left(\mathrm{V}_{\text {LINmain }}\right)$.
3. Auxiliary switching regulator2 ( $\mathrm{V}_{\text {AUX2_sW }}$ ) (Not system regulator).

### 8.6.3 Regulators mode

In this configuration bridge 4 can be configured by firmware while bridge 3 is configured as two separate synchronous switching regulators, but the start up sequence is different previous one.

When in this mode the power-up sequence is:

1. Main switching regulator $\left(\mathrm{V}_{\mathrm{SWmain}}\right)$.
2. Auxiliary switching regulator1 $\left(\mathrm{V}_{\mathrm{AUX} 1} \mathrm{sw}\right)$
3. Auxiliary switching regulator2 ( $\mathrm{V}_{\mathrm{AUX} 2}$ _sw $)$

### 8.6.4 Simple regulator mode (KT)

Also in this configuration bridge 4 can be configured by firmware while bridge 3 is configured as two separate synchronous switching regulators. The last regulator in the sequence $\left(\mathrm{V}_{\text {SWmain }}\right)$ is not considered a system regulator.

When in this mode the power-up sequence is:

1. Auxiliary switching regulator1 ( $\mathrm{V}_{\mathrm{AUX1}}$ _sw $)$.
2. Auxiliary switching regulator2 $\left(\mathrm{V}_{\mathrm{AUX} 2}\right.$ _Sw $)$
3. Main linear regulator ( $\mathrm{V}_{\text {LINmain }}$ )
4. Main switching regulator ( $\mathrm{V}_{\mathrm{SW} \text { main }}$ ) (not system regulator).

### 8.6.5 Bridge + $\mathrm{V}_{\mathrm{EXT}}$ mode

In this configuration bridges 3 and 4 are not used as regulators and the regulator obtained using the switching regulator controller ( $\mathrm{V}_{\text {SWDRV }}$ ) is included in start-up.

When in this mode the power-up sequence is:

1. Main switching regulator $\left(\mathrm{V}_{\mathrm{SWmain}}\right)$.
2. Switching regulator controller regulator ( $\mathrm{V}_{\text {SWDRV }}$ ).
3. Main linear regulator ( $\mathrm{V}_{\text {LINmain }}$ ).

### 8.6.6 Secondary regulators mode

In this configuration, bridge 3 is configured as a single synchronous switching regulator using its two half bridges in parallel $\left(\mathrm{V}_{\mathrm{AUX}}\right.$ ( $1 / / 2$ )SW).
When in this mode the power-up sequence is:

1. Main switching regulator $\left(\mathrm{V}_{\mathrm{SW} \text { main }}\right)$.
2. Auxiliary switching regulator $\left(\mathrm{V}_{\mathrm{AUX}(1 / 2) \_\mathrm{SW}}\right)$.
3. Main linear regulator ( $\mathrm{V}_{\text {LINmain }}$ ).

## $9 \quad$ Power sequencing

As soon as $\mathrm{V}_{\text {Supply }}$ and $\mathrm{V}_{\text {Supplyint }}$ are above their power on reset level, L 6460 will start the charge pump circuit; once $V_{\text {Pump }}$ voltage reaches its under voltage rising threshold, L6460 begins a sequence that starts the regulators considered system regulators.

A regulator is considered a System regulator if:

- It has to start in on state without any user action.
- It is included in the power-up sequence.
- Its under-voltage event is considered by L6460 as an error condition to be signaled through nRESET pin.

Once $\mathrm{V}_{\text {Supply }}$ and $\mathrm{V}_{\text {SupplyInt }}, \mathrm{V}_{\text {Pump }}$ and all the system regulators are over their under voltage rising threshold, L6460 enters in the normal operating state, that will release nRESET pin and will wait for SPI commands.

L6460 will reduce the noise introduced in the system by switching out of phase all its power circuits (switching regulators, bridges and charge pump).
The L6460's startup sequence of operation is the following:

- start $\mathrm{V}_{3 \mathrm{v} 3}$ internal linear regulator
- sample startup configuration
- wait enable if slave device
- start charge pump
- $\quad$ start system regulators (see order in Section 8.6)
- if master send enable to slave device
- wait until $\mathrm{V}_{\text {GPIO }}$ spI becomes ok


## 10 Power saving modes

Saving power is very important for today platforms: L6460 implements different functions to achieve different levels of power saving. Sections here below describe these different power saving modes.

### 10.1 Standby mode

Almost all low voltage circuitry inside L 6460 are powered by $\mathrm{V}_{3 \mathrm{v} 3}$ internal regulator; this regulator is a linear regulator powered by $\mathrm{V}_{\text {Supplylnt. }}$. This means that all the current provided by $\mathrm{V}_{3 \mathrm{v} 3}$ regulator is directly coming from $\mathrm{V}_{\text {Supplyint }}$ and therefore the total power consumption is:

$$
\text { Low voltage power }=\mathrm{V}_{\text {Supply }}{ }^{*} \mathrm{I}_{\mathrm{V} 3 \mathrm{v} 3 .}
$$

because $\mathrm{V}_{\text {SupplyInt }}$ is feeded by $\mathrm{V}_{\text {Supply, }}$, directly or with a resistor in series.
This power could be reduced by using a switching buck regulator to supply $\mathrm{V}_{3 \mathrm{v} 3}$ : in this case, assuming the buck regulator efficiency near to $100 \%$, the dissipated power would become:

$$
\text { Low voltage power } \approx 3.3 \mathrm{~V} * \mathrm{I}_{\mathrm{V} 3 \mathrm{v} 3}
$$

To achieve this result there is the need to switch off the internal $\mathrm{V}_{3 \mathrm{v} 3}$ linear regulator and to use an additional pin to provide a 3.3 V supply to internal circuits. L 6460 can do this by using the low voltage switch implemented on GPIO6 pin. This switch internally connects $\mathrm{V}_{\text {GPIO_SPI }}$ voltage to GPIO6 output so, by externally connecting GPIO6 to $\mathrm{V}_{3 \mathrm{k} 3}$ pin, the $\mathrm{V}_{\text {GPIO_SPI }}$ voltage can be provided to low voltage circuitry inside L6460.

Figure 7. Standby mode function description


The StdByMode bit used to switch off $\mathrm{V}_{3 \mathrm{v} 3}$ and switch on the power switch can be set to '1' by writing the standby command in the StdByMode register. L6460 exits standby mode if a reset event happens or "Low Power mode" is selected.
Because all internal low voltage circuitry powered by $\mathrm{V}_{3 \mathrm{v} 3}$ are designed to work with a 3.3 V voltage rail, when the standby mode is used, $\mathrm{V}_{\mathrm{GPIO}}$ SPI is requested to be at 3.3 V .

### 10.2 Hibernate mode

L6460's hibernate mode allows the firmware to switch off some (or all) selected System Regulators leaving in on state only those necessary to resume L6460 to operative condition when waked-up by an external signal.

Hibernate mode is selected when the firmware writes the command word in the HibernateCmd register. When in hibernate mode L6460 will force regulators in the state (on/off) selected by the firmware by writing in the HibernateCmd register and will force nRESET pin low.

The exiting from hibernate mode is achieved by forcing at low level nAWAKE pin (or GPIO5 pin if L6460 is in Slave mode); L6460 will also exit from hibernate mode if an undervoltage event happens on $\mathrm{V}_{\text {Supply, }}, \mathrm{V}_{\text {Supplyint }}, \mathrm{V}_{\text {Pump }}$ or $\mathrm{V}_{3 \mathrm{k} 3}$.
When the exit from hibernate mode is due to an external command, L6460 sets to ' 1 ' the bit HibModeLth in the HibernateStatus register.

### 10.3 Low power mode

When in normal operating mode, the microcontroller can place L6460 in "Low Power mode".
In this condition L6460 sets all bridges outputs in high impedance, powers down all regulators (including system regulators and charge pump) and disables almost all its circuits including internal clock reducing as much as possible power consumption.

The only circuits that remain active are:
$-\quad \mathrm{V}_{3 \mathrm{~V} 3}$ internal regulator.

- nAWAKE pin current pull-up.
- nRESET pin that will be pulled low.
- POR circuit.

The entering in low power mode is obtained in different ways depending if L6460 is configured as slave device or not. When L6460 is configured as slave device the low power mode is directly controlled by nAWAKE pin that acts as an enable: if this pin is low for a time longer then $\mathrm{t}_{\text {AWAKEFILT, }}$ Low Power mode is entered; if this pin is high L6460 exits from Low Power mode.

In all other start-up configurations, Low Power mode is entered by writing a Low Power mode command in the PowerModeControl register; once L6460 is in Low Power mode it starts checking the nAWAKE pin status: if it is found low for a time longer than $t_{\text {AWAKEFILT }}$, L6460 exits from Low Power mode and restarts its startup sequence. When the nAWAKE pin is externally pulled low, the "AWAKE" event is stored and it is readable through SPI. L6460 will also exit from Low Power mode if a POR event is found.

Note: $\quad W h e n ~ i n ~ " L o w ~ p o w e r ~ m o d e " ~ V S u p p l y ~ i s ~ m o n i t o r e d ~ o n l y ~ f o r ~ i t s ~ p o w e r ~ o n ~ r e s e t ~ l e v e l . ~$

## 10.4 nAWAKE pin

At the start up, before L6460 has identified the required operation mode (see Chapter 8), a current sink $I_{\text {INP }}$ is always active to pull down nAWAKE pin. As soon as the operation mode (basic, slave, master or single device) is detected, the functionality of nAWAKE pin will be different.

If L6460 is not configured as slave device a current source lout will be active on this pin, while the current sink $I_{\text {INP }}$ will be disabled. If L6460 is configured as a Slave device, the current sink $\mathrm{I}_{\mathrm{INP}}$ will be active until nAWAKE pin is detected high for the first time; after that both current sources $\mathrm{I}_{\mathrm{INP}}$ and $\mathrm{I}_{\mathrm{OUT}}$ will be disabled and the nAWAKE pin can be considered as a digital input.

Here below is reported the nAWAKE pin simplified schematic.
Figure 8. nAWAKE function block diagram


## 11 Linear main regulator

The linear main regulator is directly powered by $\mathrm{V}_{\text {Supply }}$ voltage and it is one of the regulators that L 6460 could consider as a system regulator. This means that the voltage generated by this regulator is not used to power any internal circuit, but L6460 will check that the feedback voltage $\mathrm{V}_{\text {LINmain }}$ FB is in the good value range before enabling all its internal functions. When an under-voltage event (with a duration longer than period $t_{\text {prim_uv }}$ defined by the deglitch filter) is detected during normal operation, L6460 will enter in reset state and it will signal this event to the microcontroller by pulling low the nRESET pin and disabling most of its internal blocks.

Here are summarized the primary features of the regulator:

- Regulated output voltage from 0.8 V to $\mathrm{V}_{\text {Supply }}-2 \mathrm{~V}$ with a maximum load of 10 mA .
- Band gap generated internal reference voltage.
- $\quad$ Short circuit protected (output current is clamped to 22 mA typ).
- Under voltage signal (both continuous and latched) accessible through serial interface.
- Low power dissipation mode.

The internal series element is a P -channel MOS device. The voltage regulator will regulate its output so that feedback pin equals $\mathrm{V}_{\text {LINmain_FB }}$, therefore the regulated voltage can be calculated using the formula:

$$
V_{\text {LINmain_OUT }}=V_{\text {LINmain_ref }} *\left(R_{a}+R_{b}\right) / R_{b}
$$

Figure 9. Linear main regulator


To extend the output current capability this regulator can be used as a controller for an external active component able to provide higher current (i.e. a Darlington device); the external power element allows the handling of an higher current since it dissipates the power externally (the power dissipated by a linear driver supplied at $\mathrm{V}_{\text {Supply }}$ and regulating a voltage $\mathrm{V}_{\text {LINmain_OUT }}$ with an output current $\mathrm{l}_{\text {OUT }}$ is about: $\mathrm{P}_{\mathrm{d}}=\left(\mathrm{V}_{\text {Supply }}-\mathrm{V}_{\text {LINmain_OUT }}\right)^{*} \mathrm{l}_{\text {OUT }}$.

Figure 10. Linear main regulator with external bipolar for high current


Whichever configuration is used (regulator or controller), a ceramic capacitor must be connected on the output pin towards ground to guarantee the stability of the regulator; the value of this capacitance is in the range of 100 nF to $1 \mu \mathrm{~F}$ depending on the regulated voltage;

- $\mathrm{V}_{\text {LINmain_OUT }}=0.8 \mathrm{~V}-->1 \mu \mathrm{~F}$
- $0.8 \mathrm{~V}<\mathrm{V}_{\text {LINmain_OUT }}<2.5 \mathrm{~V}$--> $0.68 \mu \mathrm{~F}$
- $2.5 \mathrm{~V}=\mathrm{V}_{\text {LINmain_OUT }} 5 \mathrm{~V}->0.33 \mu \mathrm{~F}$
- $V_{\text {LINmain_OUT }}>5 \mathrm{~V}->0.1 \mathrm{~F}$

When this regulator is disabled, the whole circuit is switched off and the current consumption is reduced to a very low level both from $\mathrm{V} 3 v 3$ and from $\mathrm{V}_{\text {Supply }}$. When in this condition, the output pin is pulled low by an internal switch.

## 12 Main switching regulator

Main switching regulator is an asynchronous switching regulator intended to be the source of the main voltage in the system. It implements a soft start strategy and could be a system regulator so even if its output voltage $\mathrm{V}_{\text {SWmain }}$ is not used to power any internal circuit, L6460 will check that it is in the good value range before enabling all its internal functions. When L6460 detects a system regulator under-voltage event with a duration longer than the period defined by the deglitch filter ( $t_{\text {prim_uv }}$ ), it will enter in reset state signaling this event to the microcontroller by pulling low the nRESET pin and disabling most of its internal block (e.g. bridges, GPIOs, ...).

The output voltage will be externally set by a divider network connected to feedback pin. To reduce as much as possible the regulation voltage error L6460 has the possibility to choose between four feedback voltage references (and, as a consequence, four under-voltage thresholds) using the serial interface. The feedback reference voltage selection is made by writing the SelFBRef bits in the MainSwCfg register.

Here after are summarized the primary features of this regulator:

- Internal power switch.
- Soft start circuitry to limit inrush current flow from primary supply.
- Internally generated PWM ( 250 kHz switching frequency).
- Nonlinear pulse skipping control.
- Protected against load short circuit.
- Cycle by cycle current limiting using internal current sensor.
- Under voltage signal (both continuous and latched) accessible through SPI.

When L6460 is in "low power mode", this regulator will be disabled.
In order to save external components and power when using two or more L6460 IC's on the same board, the primary switching regulator can be disabled by serial interface. Care must be paid using this function because an under-voltage on this regulator, as previously seen, will be read as a fault condition by L6460.

### 12.1 Pulse skipping operation

Pulse skipping is a well known, non linear, control strategy used in switching regulators.
In this technique (see Figure 11) the feedback comparator output is sampled at the beginning of each switching cycle. At this time, if the sampled value shows that output voltage is lower than requested one, the complete PWM duty cycle is applied to power switch; otherwise no PWM is applied and the switching cycle is skipped. Once PWM is applied to power element only a current limit event can disable the power switch before the whole duty cycle is finished.

Figure 11. Main switching regulator functional blocks


In pulse skipping control the duty cycle must be chosen by the user depending on supply voltage and output regulated voltage. Therefore the switching regulator has 4 possible duty cycles that can be changed by writing the VmainSwSeIPWM bits in the MainSwCfg register according to following Table 10.

Table 10. Main switching regulator PWM specification

| MainSwCfg register | Duty cycle value | Comments |
| :---: | :---: | :---: |
| VmainSwSelPWM[1:0] | Typical |  |
| 00 | $12 \%$ |  |
| 01 | $15 \%$ |  |
| 10 | $26 \%$ | Default state |
| 11 | $63.5 \%$ |  |

The output current is limited to a value that can be set by means of Selllimit bit in the MainSwCfg register according to following Table 11.

Table 11. Main switching regulator current limit

| Sellimit | Current limit (min) | Comments |
| :---: | :---: | :---: |
| 0 | 3.3 A | Default state |
| 1 | 2.3 A |  |

## 13 Switching regulator controller

This circuit controls an external FET to implement a switching buck regulator using a non linear pulse skipping control with internally generated PWM signal.

The output voltage will be externally set by a divider network connected on feedback pin. To reduce as much as possible the regulation voltage error L6460 has the possibility to switch between four regulator feedback voltage references (and, as a consequence, four undervoltage thresholds) using serial interface. The feedback reference voltage is selected by writing the SelFBRef bits in the SwCtrCfg.

This regulator is switched off when L6460 is powered up for the first time and can be enabled using L6460's SPI interface.

Here after are summarized the main features of the regulator:

- Soft start circuitry to limit inrush current flow from primary supply.
- Changeable feedback reference voltage
- Internally generated PWM ( 250 kHz switching frequency).
- Nonlinear pulse skipping control.
- Protected against load short circuit.
- Cycle by cycle current limiting using internal current sensor.
- Under voltage signal (both continuous and latched) accessible through SPI.

Figure 12. Switching regulator controller functional blocks


### 13.1 Pulse skipping operation

Pulse skipping strategy has already been explained on main switching regulator section.
This regulator has 4 possible PWM duty cycles that can be changed writing in the SelSwCtrPWM bits in the SwCtrCfg register using SPI.

Table 12. Switching regulator controller PWM specification

| SwCtrCfg register | Duty cycle value | Comments |
| :---: | :---: | :---: |
| SelSwCtrPWM[1:0] | Typical |  |
| 00 | $9 \%$ |  |
| 01 | $12 \%$ |  |
| 10 | $22.5 \%$ |  |
| 11 | $58 \%$ | Default state |

### 13.2 Output equivalent circuit

The switching regulator controller output driving stage can be represented with an equivalent circuit as in the Figure 13:

Figure 13. Switching regulator controller output driving: equivalent circuit


As can be seen from the above figure, the external switch gate is charged with a current generator $I_{\text {SOURCE }}$ and it is discharged towards ground with a current generator $\mathrm{I}_{\text {SINK }}$ that is applied for a $T_{\text {SINK }}$ pulse while an equivalent resistor $R_{\text {SUSTAIN }}$ is connected between gate and source until the sink command is present.

### 13.3 Switching regulator controller application considerations

This controller can implement a step-down switching regulator used to provide a regulated voltage in the range $0.8 \mathrm{~V}-32 \mathrm{~V}$. Such kind of variation could be managed by considering some constraints in the application and particularly by choosing the correct feedback reference voltage as indicated in the Table 13.

Table 13. Switching regulator controller application: feedback reference

| Output regulated voltage range | Feedback voltage reference |
| :---: | :---: |
| $0.8 \mathrm{~V} \leq \mathrm{V}_{\text {out }}<5 \mathrm{~V}$ | $0.8 \mathrm{~V}-1 \mathrm{~V}$ |
| $5 \mathrm{~V} \leq \mathrm{V}_{\text {out }} \leq 32 \mathrm{~V}$ | $2.5 \mathrm{~V}-3 \mathrm{~V}$ |

An example of application can be considered the following, supposing the external mosfet type STD12NF06L:

- Max DC current load $=3$ A
- $\quad$ Typ Over current threshold $=3$ A * $1.5=4.5 \mathrm{~A}$
- $L=150 \mu \mathrm{H}$
- $\quad \mathrm{C}=220-330 \mu \mathrm{~F}$

In this conditions the step-down regulator will result over-load protected, short-circuit protected over all the regulated voltage range and the $\mathrm{V}_{\text {Supply }}$ range.
Other application configurations could be evaluated before being implemented.

## 14 Power bridges

L6460 includes four H bridge power outputs (each one made by two independent half bridges) that are configurable in several different configurations.

Each half bridge is protected against: over-current, over-temperature and short circuit to ground, to supply or across the load. When an over current event occurs, all outputs are turned off (after a filter time), and the over current bit is stored in the internal status register that can be read through SPI.

Positive and negative voltage spikes, which occur when switching inductive loads, are limited by integrated freewheeling diodes (see Figure 14).

Figure 14. H Bridge block diagram


During the start up procedure the bridges are in high impedance and after that they can be enabled through SPI. When a fault condition happens, i.e. an over-temperature event, the bridges return in their start-up condition and they need to be re-enabled from the micro controller.

The bridges can use PWM signals internally generated or externally provided (supplied through the GPIO pins). Internally generated PWM signals will run at approximately 31.25 kHz with a duty cycle that, through serial interface, can be programmed and incremented in steps of $1 /\left(512^{*} \mathrm{~F}_{\text {osc }}\right)$. To reduce the peak current requested from supply voltage when all bridges are switching, the four internally generated PWM signals are out-of-phase.

Each half bridge will use the PWM signal selected by the respective MtrXSeIPWMSideY[1:0] (X stands for 1, 2, 3 or 4 ; Y stands for A or B) bits in the SPI, but if two half bridges are configured as a full bridge, only the PWM signal chosen for side A will be used to drive the resulting H bridge.

More in detail the PWM selection truth table will be as describe in the following tables:

Table 14. PWM selection truth table for bridge 1 or 2

| MtrXSeIPWMSideY [1] | MtrXSeIPWMSideY [0] | Selected PWM ${ }^{(1)}$ |
| :---: | :---: | :---: |
| 0 | 0 | MotorXPWM (Configurable by means of MtrXCfg <br> register). |
| 0 | 1 | AuxXPWM (Configurable by means of <br> AuxPwmXCtrl register). |
| 1 | 0 | ExtPWM1 (from GPIO 9 input) |
| 1 | 1 | ExtPWM2 (from GPIO 10 input) |

1. In this table $X$ stands for 1 or $2, Y$ stands for $A$ or $B$.

Table 15. PWM selection truth table for bridge 3 or 4

| MtrXSeIPWMSideY [1] | MtrXSeIPWMSideY [0] | Selected PWM ${ }^{(1)}$ |
| :---: | :---: | :---: |
| 0 | 0 | MotorXPWM (Configurable by means of <br> MtrXCfg register). |
| 0 | 1 | AuxXPWM (Configurable by means of <br> AuxPwmXCtrl register). |
| 1 | 0 | ExtPWM3 (from GPIO 2 input) |
| 1 | 1 | ExtPWM4 (from GPIO 11 input) |

1. In this table $X$ stands for 3 or $4, Y$ stands for $A$ or $B$.

In Figure 15 is reported a block diagram representing the possible PWM choices for each L6460 half bridges. The figure is related only to bridges 1 and 2, but it could be assumed to be valid also for bridges 3 and 4, with few differences due to different possible configurations of these last drivers.

Figure 15. Bridge 1 and 2 PWM selection


### 14.1 Possible configurations

The selection of the bridge configuration is done through SPI, by writing the MtrXTable[1:0] bits in the MtrXCfg register. The table below shows the correspondence between MtrXTable[1:0] bits and the bridge configuration.

Table 16. Bridge selection

| MtrXTable[1] | MtrXTable[0] | Bridge configuration |
| :---: | :---: | :--- |
| 0 | 0 | Full bridge |
| 0 | 1 | High or low side switch |
| 1 | 0 | Half bridge |
| 1 | 1 | High or low side switch |

Bridge 1 \& 2 can be paralleled by means of Mtr1_2Parallel bit in the Mtr1_2Cfg register: Bridge 1 and 2 paralleled will form superbridge1, bridge $X$ side $A$ and bridge $X$ side $B$ paralleled form SuperHalfBridgeX or SuperSwitchX.

Bridge 3 \& 4 can be configured by means of Mtr3_4CfgTable[1:0] bits in the Mtr3_4Cfg register according to following table:

Table 17. Bridge 3 and 4 configuration

| Mtr3_4CfgTable[1] | Mtr3_4CfgTable[0] | Bridge 3 and 4 configuration |
| :---: | :---: | :---: |
| 0 | 0 | Two independent bridges |
| 0 | 1 | Two bridges in parallel |
| 1 | 0 | Stepper motor |
| 1 | 1 | Stepper motor |

The possible configurations for the bridges are described in the following.

### 14.1.1 Full bridge

When in full bridge configuration, the drivers will behave according to the following truth table:

Table 18. Full bridge truth table

| TSD | nRESET | Low <br> power <br> mode | Enable | Current <br> limit | MtrXCtrI <br> SideA | MtrXCtrl <br> SideB | PWM | OUT+ | OUT- |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | X | X | X | X | X | X | X | Z | Z |
| 0 | 0 | X | X | X | X | X | X | Z | Z |
| 0 | 1 | 1 | X | X | X | X | X | Z | Z |
| 0 | 1 | 0 | 0 | X | X | X | X | Z | Z |
| 0 | 1 | 0 | 1 | 1 | X | X | X | Z | Z |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | X | 0 | 0 |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | 1 | 1 |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | X | 1 | 1 |

Note: $\quad$ Note: When "Iow power mode" is active, the bridges will enter in low power state and will reduce its biasing thus contributing to the power saving.

When a current limit event occurs this event will be latched and the bridges will remain in high impedance state for the off time.

### 14.1.2 Parallel configuration (super bridge)

Bridges 1, 2, 3 and 4 can be configured to be used two by two (1 plus 2, 3 plus 4) as one super bridge thus enabling the driving of loads (motors) requiring high currents. In this configuration the half bridges will be paralleled and will work as one phase of the superbridge just created: the two phases + will become phase + of the newly created superbridge while the two phases - will become phase -.

Figure 16. Super bridge configuration


When this configuration is chosen for bridges 1 (3) and 2 (4), the resulting bridge will use the driving logic of bridge 1 (3) so for programming it must be used the bridge 1 (3) control and status bits (direction, PWM, ...): i.e. the used PWM signal will be chosen by Mtr1SideAPwmSel[1:0] (Mtr3SideAPwmSel[1:0]) bits in SPI.

If the bridges are not configured to be used in parallel, each side of the bridge will use the PWM selected by the respective MtrXPWMYSel[1:0] bits in the SPI, but if one of the two drivers is configured as a full bridge only one of the two selected PWM will be used to drive the motor and this is the PWM chosen for side A.

In order to avoid any problem coming from different propagation times of PWM signals the anti-crossover dead times are slightly increased when the bridges are paralleled.

### 14.1.3 Half bridge configuration

Each bridge can be configured to be used as 2 independent half bridges or as 1 super half bridge (see Figure 17). It is also possible to parallel more than one bridge and use all of them as a single super half bridge.

Figure 17. Half bridge configuration


In this case each half bridge will behave according to the following truth table.
Table 19. Half bridge truth table

| TSD | nReset | Low <br> power <br> mode | Enable | Current <br> limit | MtrXCtrI <br> SideA/B | PWM | OUT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | $X$ | $X$ | X | X | X | X | Z |
| 0 | 0 | X | X | X | X | X | Z |
| 0 | 1 | 1 | X | X | X | X | Z |
| 0 | 1 | 0 | 0 | X | X | X | Z |
| 0 | 1 | 0 | 1 | 0 | 0 | 0 | Z |
| 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | Z |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 |
| 0 | 1 | 0 | 1 | 1 | $X$ | X | Z |

Note: When "low power mode" bit is active the bridges will reduce its biasing thus contributing to the power saving.
When a current limit event occurs this event will be latched and the bridges will remain in high impedance state for the off time.

### 14.1.4 Switch configuration

Each bridge can be configured to be used as 2 independent switches that connects the output to supply or to ground. It is also possible to parallel the two switches and use them as a single super switch.
All resulting switches will behave according to the following truth table.
Table 20. Switch truth table

| TSD | nReset | Low <br> power <br> mode | Enable | Current <br> limit | MtrXCtrI <br> SideA/B | PWM | OUT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | X | X | X | X | X | X | Z |
| 0 | 0 | X | X | X | X | X | Z |
| 0 | 1 | 1 | X | X | X | X | Z |
| 0 | 1 | 0 | 0 | X | X | X | Z |
| 0 | 1 | 0 | 1 | 0 | 0 | X | Z |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 |
| 0 | 1 | 0 | 1 | 1 | X | X | Z |

Note: When "low power mode" bit is active the bridge will reduce its biasing thus contributing to the whole power saving.
When a current limit event occurs this event will be latched and the bridge will remain in high impedance state for the toff time.

### 14.1.5 Bipolar stepper configuration

The bridges 3 and 4 can be configured to be used as a micro-stepping, bidirectional driver for bipolar stepper motors.

The primary features of the driver are the following:

- Internal PWM current control.
- Micro stepping.
- Fast, mixed and slow current decay modes.

Each H-bridge is controlled with a fixed and selectable off-time PWM current control circuit that limits the load current to a value set by choosing $V_{\text {STEPREF }}$ voltage by means of the internal DAC and an the external R $_{\text {SENSE }}$ value.

The max current level could be calculated using the formula:

$$
\mathrm{I}_{\mathrm{MAX}}=\mathrm{V}_{\text {STEPREF }} / \mathrm{R}_{\text {SENSE }}
$$

To obtain the best current profile, the user can choose three different current decay modes: slow, fast and mixed. Initially, during Ton, a diagonal pair of source and sink power MOS is enabled and current flows through the motor winding and the sense resistor. When the voltage across the sense resistor reaches the programmed DAC output voltage, the control logic will change the status of the bridge according to the selected decay mode (slow, fast or mixed). In slow decay mode the current is recirculated through the path including both high
side power MOS for the whole off time. In fast decay mode the current is recirculated through the high and low side power MOS opposite respect to those forcing current to increase. Mixed decay mode is a selectable mix of the previous two modes (fast decay followed by slow decay) and allows the user to find the best trade off between load current ripple and fast current levels transition. Additionally, by setting the SeqMixedOnlyInDecreasingPh bit in the StpCfg1 register, the user can choose to apply the fast decay percentage in mixed mode always or only when the current is decreasing (i.e from $90^{\circ}$ to $180^{\circ}$ and from $270^{\circ}$ to $360^{\circ}$ of the sinusoidal wave).

By using SPI interface the user can choose:

- Control type (external firmware control, half step, normal drive, wave drive, micro-step).
- Up to 16 current levels (quasi-sinusoidal increments) for each bridge.
- Current direction.
- Decay mode.
- Blanking time.
- Off time ( 32 values from $2 \mu$ s to $64 \mu \mathrm{~s}$ ).
- Percentage of fast decay respect to toff (when in mixed decay mode).

Figure 18. Bipolar stepper configuration


Using the StepCtrIMode[2:0] bits in StepCfg1 register, L6460 can be programmed to internally generate the stepping levels. In these cases and depending on the StepFromGpio bit in the StpCfg1 register the Stepper driver will move to next step each time the StepCmd bit is set at logic level " 1 " or at each pulse transition longer than $\sim 1 \mu \mathrm{~s}$ externally applied on GPIO12 (StepReq signal), according to Table 21.

Table 21. Sequencer driver

| StepFromGpio | Sequencer driver |
| :---: | :---: |
| 0 | StepCmd bit in StepCmd register. |
| 1 | GPIO12 input pin. |

The allowable control modes are as follows:

1. Stepping sequence left to external microcontroller: in this mode the current level in each motor winding is set by the microcontroller via the serial interface.
2. Full step: in this mode the electrical angle will change by $90^{\circ}$ steps at each StepReq signal transition. There are two possibilities:

- Normal step (two phases on): in normal step mode both windings are energized simultaneously and the current will be alternately reversed. The resulting electrical angles will be $45^{\circ}, 135^{\circ}, 225^{\circ}$ and $315^{\circ}$.
- Wave drive (one phase on): In wave drive mode each winding is alternately energized and reversed. The resulting electrical angles will be $90^{\circ}, 180^{\circ}$ and $270^{\circ}$ and $360^{\circ}$.

3. Half step: in this mode, one motor winding is energized and then two windings alternately so the electrical angles the motor will do when rotating in clockwise direction and using the same current limit in both the phases are: $45^{\circ}, 90^{\circ}, 135^{\circ}, 180^{\circ}, 225^{\circ}$, $270^{\circ}, 315^{\circ}$ and $360^{\circ}$.
4. Microstepping: in this mode the current in each motor winding has a quasi sinusoidal profile. The increment between each step is obtained at each transition of StepCmd bit in StepCmd register. The difference between each step could be chosen (4, 8 or 16 levels for each phase) according to following table:

Table 22. Stepper driving mode

| StepCtrIMode[2:0] | Control mode | Description |
| :---: | :---: | :--- |
| 000 or 111 | No Control | Stepping sequence control left to the external <br> controller |
| 001 | Half Step | Half step |
| 010 | Normal Step | Full step (two phases on) |
| 011 | Wave Drive | Full step (one phase on) |
| 100 | $1 / 4$ Step | Four micro steps |
| 101 | $1 / 8$ Step | Eight micro steps |
| 110 | $1 / 16$ Step | Sixteen micro steps |

Note: $\quad$ When in $1 / 16$ step mode, the best phase approximation of sinusoidal wave, is obtained by repeating the "F" step as follows: $0,1,2,3, \ldots, D, E, F, F, F, E, D, \ldots, 3,2,1,0$

When internal stepping sequence generation is used, the stepping direction is set by the StepDir bit according to the Table 23.

Table 23. Stepper sequencer direction

| StepDir | Direction |
| :---: | :---: |
| 0 | Counter clockwise (CCW) |
| 1 | Clockwise (CW) |

Note: It is intended as clockwise the sequence that forces a clockwise rotation of the versors representing the current module and phase.

An internal DAC is used to digitally control the output regulated current. The available values are chosen to provide a quasi sinusoidal profile of the current. The current limit in each phase is decided by PhADAC[3:0] bits for phase $A$ and $\operatorname{PhBDAC}[3: 0]$ bits for phase $B$. The table below describes the relation between the value programmed in the stepper DAC and the current level.

Table 24. DAC

| PhXDAC [3:0] | Phase current ratio respect to $\mathrm{I}_{\text {MAX }}$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max | Unit |
| 0000 |  | (Hi-Z) |  |  |
| 0001 | - | 9.8 | - | \% of $\mathrm{I}_{\text {MAX }}$ |
| 0010 | - | 19.5 | - | $\%$ of $\mathrm{ImAX}^{\text {m }}$ |
| 0011 | - | 29.0 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 0100 | - | 38.3 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 0101 | - | 47.1 |  | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 0110 | - | 55.6 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 0111 | - | 63.4 | - | $\%$ of $I_{\text {MAX }}$ |
| 1000 | - | 70.7 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1001 | - | 77.3 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1010 | - | 83.1 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1011 |  | 88.2 | - | \% of IMAX |
| 1100 |  | 92.4 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1101 |  | 95.7 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1110 | - | 98.1 | - | $\%$ of $\mathrm{I}_{\text {MAX }}$ |
| 1111 | - | $\mathrm{I}_{\text {MAX }}$ | - |  |

Note:
The min and max values are guaranteed by testing the percentage of VSTEPREF that allows the commutation of the Rsense comparator.
$I_{M A X}=V_{\text {STEPREF }} R_{\text {SENSE }}$.
To obtain the best phase approximation of a sinusoidal wave, the user needs to repeat the final (100\%) value. So the full values sequence should be as follows: $0,1,2,3 \ldots D, E, F, F$, $F, E, D \ldots 3,2,1,0$.

Even if the total spread shows overlapping between current steps, the monotonicity is guaranteed by design.
When the internal sequencer the minimum angle resolution is nominally $5.625^{\circ}$, so depending on the control mode chosen, the selectable steps are Table 25.

Table 25. Internal sequencer

| Control mode |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |

Table 25. Internal sequencer (continued)

| Control mode |  |  |  |  |  | Typical output current (\% of IMAX) |  | Resulting electrical angle |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Half step | Full step (2 phases on) | Full step <br> (1 phase <br> on) | $\begin{gathered} 1 / 4 \\ \text { step } \end{gathered}$ | $\begin{gathered} 1 / 8 \\ \text { step } \end{gathered}$ | $\begin{aligned} & 1 / 16 \\ & \text { step } \end{aligned}$ | Phase A (sin) | Phase B (cos) | Electrical degrees |
|  | 3 |  |  |  | 32 | -63.4 | -77.3 | $219.4^{\circ}$ |
| 5 |  |  | 9 | 17 | 33 | -70.7 | -70.7 | $225{ }^{\circ}$ |
|  |  |  |  |  | 34 | -77.3 | -63.4 | $230.6^{\circ}$ |
|  |  |  |  | 18 | 35 | -83.1 | -55.6 | $236.2^{\circ}$ |
|  |  |  |  |  | 36 | -88.2 | -47.1 | $241.9^{\circ}$ |
|  |  |  | 10 | 19 | 37 | -92.4 | -38.3 | $247.5^{\circ}$ |
|  |  |  |  |  | 38 | -95.7 | -29.0 | $253.1^{\circ}$ |
|  |  |  |  | 20 | 39 | -98.1 | -19.5 | $258.8^{\circ}$ |
|  |  |  |  |  | 40 | -100 | -9.8 | $264.4^{\circ}$ |
| 6 |  | 3 | 11 | 21 | 41 | - -100 | HiZ | $270^{\circ}$ |
|  |  |  |  | - | 42 | -100 | 9.8 | $275.6^{\circ}$ |
|  |  |  |  | 22 | 43 | -98.1 | 19.5 | $281 .{ }^{\circ}$ |
|  |  |  |  |  | 44 | -95.7 | 29.0 | $286.9^{\circ}$ |
|  |  | - | 12 | 23 | 45 | -92.4 | 38.3 | $292.5^{\circ}$ |
|  |  | $\times$ |  |  | 46 | -88.2 | 47.1 | $298.1^{\circ}$ |
|  | 1 |  |  | 24 | 47 | -83.1 | 55.6 | $303.8^{\circ}$ |
|  |  |  |  |  | 48 | -77.3 | 63.4 | $309.4{ }^{\circ}$ |
| 7 | 4 |  | 13 | 25 | 49 | -70.7 | 70.7 | $315^{\circ}$ |
|  |  |  |  |  | 50 | -63.4 | 77.3 | $320.6^{\circ}$ |
|  |  |  |  | 26 | 51 | -55.6 | 83.1 | $326.2^{\circ}$ |
|  |  |  |  |  | 52 | -47.1 | 88.2 | $331.9^{\circ}$ |
|  |  |  | 14 | 27 | 53 | -38.3 | 92.4 | $337.5^{\circ}$ |
|  |  |  |  |  | 54 | -29.0 | 95.7 | $343.1^{\circ}$ |
|  |  |  |  | 28 | 55 | -19.5 | 98.1 | $348.8^{\circ}$ |
|  |  |  |  |  | 56 | -9.8 | 100 | $354.4^{\circ}$ |
| 8 |  | 4 | 15 | 29 | 57 | Hiz | 100 | $360 \%{ }^{\circ}$ |
|  |  |  |  |  | 58 | 9.8 | 100 | $5.6{ }^{\circ}$ |
|  |  |  |  | 30 | 59 | 19.5 | 98.1 | $11.2^{\circ}$ |
|  |  |  |  |  | 60 | 29.0 | 95.7 | $16.9{ }^{\circ}$ |
|  |  |  | 16 | 31 | 61 | 38.3 | 92.4 | $22.5{ }^{\circ}$ |
|  |  |  |  |  | 62 | 47.1 | 88.2 | $28.1^{\circ}$ |

Table 25. Internal sequencer (continued)

| Control mode |  |  |  | Typical output <br> current (\% of IMAX) |  | Resulting <br> electrical <br> angle |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Half <br> step | Full step <br> $(\mathbf{2}$ phases <br> on) | Full step <br> (1 phase <br> on) | $\mathbf{1 / 4}$ <br> step | $\mathbf{1 / 8}$ <br> step | $\mathbf{1 / 1 6}$ <br> step | Phase A <br> (sin) | Phase B <br> (cos) | Electrical <br> degrees |
|  |  |  |  | 32 | 63 | 55.6 | 83.1 | $33.8^{\circ}$ |
|  |  |  |  |  | 64 | 63.4 | 77.3 | $39.4^{\circ}$ |

The voltage spikes on $R_{\text {sense }}$ could be filtered by selecting an appropriate blanking time on the output of current sense comparator. The Blanking time selection is made by using the StepBlkTime[1:0] bits in the StpCfg1 register.

The stepper driver off time could be programmed by means of the StepOffTime[4:0] bits in StpCfg1 register.

Table 26. Stepper off time


Table 26. Stepper off time (continued)

| StepOffTime[4:0] | Off time | Unit |
| :---: | :---: | :---: |
|  |  |  |
| 10100 | 42 | $\mu \mathrm{~s}$ |
| 10101 | 44 | $\mu \mathrm{~s}$ |
| 10110 | 46 | $\mu \mathrm{~s}$ |
| 10111 | 48 | $\mu \mathrm{~s}$ |
| 11000 | 50 | $\mu \mathrm{~s}$ |
| 11001 | 52 | $\mu \mathrm{~s}$ |
| 11010 | 54 | $\mu \mathrm{~s}$ |
| 11011 | 56 | $\mu \mathrm{~s}$ |
| 11100 | 58 | $\mu \mathrm{~s}$ |
| 11101 | 60 | $\mu \mathrm{~s}$ |
| 11110 | 62 | $\mu \mathrm{~s}$ |
| 11111 | 64 | $\mu \mathrm{~s}$ |

By means of MixDecPhA[4:0] and MixDecPhB[4:0] in StepCfg2 register, the percentage of off time during which each phase will stay in fast decay mode could be programmed according to Table 28.

Table 27. Stepper fast decay

| MixDecPhX[4:0] | Fast decay percentage <br> during off time | Unit |
| :---: | :---: | :---: |
|  | Typ |  |
| 00000 | 0 | $\%$ |
| 00001 | 6.25 | $\%$ |
| 00010 | 12.5 | $\%$ |
| 00011 | 18.75 | $\%$ |
| 00100 | 25 | $\%$ |
| 00101 | 31.25 | $\%$ |
| 00110 | 37.6 | $\%$ |
| 00111 | 43.75 | $\%$ |
| 01000 | 50 | $\%$ |
| 01001 | 56.25 | $\%$ |
| 01010 | 62.5 | $\%$ |
| 01011 | 68.75 | $\%$ |
| 01100 | 75 | $\%$ |
| 01101 | 81.25 | $\%$ |
| 01110 | 87.5 | $\%$ |
| 01111 | 93.75 | $\%$ |
| $1 \times x x x$ |  | 100 |

### 14.1.6 Synchronous buck regulator configuration (Bridge 3)

Bridge 3 can be configured to be used as 2 independent synchronous buck regulators or as a single high current synchronous buck regulator using GPIOs pins in order to close the voltage loop. The resulting regulator(s) will implement a non linear, pulse skipping, control loop using an internally generated PWM signal. The voltage will be set externally with a divider network and PWM duty cycle that can be programmed in order to ensure a proper regulation.

The regulator will be enabled/disabled using serial interface and will implement a soft start strategy similar to that used by primary switching regulator.

Here after are summarized the primary features of the regulator(s):

- Synchronous rectification
- Automatic low side disabling when current in the inductance reaches 0 to optimize efficiency at low load
- Pulse skipping control
- Internally generated PWM
- Cycle by cycle current limiting using internal current sensor
- Protected against load short circuit
- Soft start circuitry
- Under voltage signal (both continuous and latched) accessible through serial interface.

Figure 19. Regulator block diagram


Depending on the load current, there could be the necessity to add a Schottky diode on output to reduce internal thermal dissipation. This diode must be placed near to the pin and must be fast recovery and low series resistance type.

For detail about pulse skipping please refer to main switching regulator Section 13.3 on page 54.

The output voltage will be externally set by a divider network connected on feedback pin. To reduce as much as possible the regulation voltage error L6460 has the possibility to switch between four regulator feedback voltage references (and, as a consequence, four under-
voltage thresholds) using serial interface. The feedback reference voltage is selected by writing the SelFBRef[1:0] bits in the Aux1SwCfg or Aux2SwCfg registers.
The switching regulators have four possible PWM duty cycles that can be changed using SPI according to Table 28.

Table 28. PWM specification

| AuxXPWMTable[1:0] | Typical duty cycle value | Comments |
| :---: | :---: | :---: |
| 00 | $10 \%$ |  |
| 01 | $13 \%$ | Default state for AUX1 |
| 10 | $24 \%$ | Default state for AUX2 |
| 11 | $61 \%$ |  |

### 14.1.7 Regulation loop

As seen before L6460 contains 2 regulation loops for switching regulators that are used when bridge 3 is used as a regulator. These loops are assembled using internal comparators and filters similar to that used in main switching regulator.
When bridge 3 is not used for this purpose or when only one regulation loop is needed, the control loop is available on a GPIO output thus enabling the customer to assembly a basic buck switching regulator using an external Power FET. The comparators used in the above mentioned regulation loops are general purpose low voltage ( 3.3 V ) comparators; when the relative regulation loop is not used they can be accessed as shown in the Figure 20.

Figure 20. Internal comparator functional block diagram


### 14.1.8 Battery charger or switching regulator (Bridge 4)

The functionality of this circuit is obtained by using the bridge 4 output stage. This circuit is powered directly from $\mathrm{V}_{\text {Supply }}$ and it is intended to be used as a battery charger or a switching regulator.

The control loop block diagram is shown in the Figure 21.

Figure 21. Battery charger control loop block diagram


The battery charger control loop implements an asynchronous switching regulator intended to be used as a constant voltage/constant current programmable source.

When used as a simple switching regulator, it could be a system regulator depending on startup configurations

When a system regulator under-voltage event is detected L6460 will enter in reset state signaling this event to the microcontroller by pulling low the nRESET pin and disabling most of its internal blocks.

When the control loop is intended to be used as a battery charger, the Aux3BatteryCharge bit must be written in the Aux3SwCfg1 register. This is because in this case the undervoltage event that will be sure present when charging a battery (see battery charger profile in Figure 22) will not be considered during start up sequence.

The regulated output voltage will be externally set by a resistor divider network connected to $V_{\text {REF_FB }}$ pin. L6460 has the possibility to choose between four voltage references (and, as a consequence, four under-voltage thresholds) using the serial interface. The feedback reference voltage selection is made by writing the SelFBRef[1:0] bits in the Aux3SwCfg1 register.

The regulation of the output current can be done externally, by using a sense resistor connected in series on the path that provides current to the load. By using an external differential amplifier the customer can set the desired $V=f(I)$ characteristic, and therefore
the regulated current: the voltage provided at the $\mathrm{I}_{\text {REF_FB }}$ pin will be compared to the internal reference. L6460 has the possibility to choose between four voltage references using the serial interface, writing the SelCurrRef[1:0] bits in the Aux3SwCfg1 register.

Regardless of the CurrRef voltage, if the $\mathrm{I}_{\text {REF_FB }}$ pin remains below the chosen threshold, the internal current limitation will work (typical llimit current 4A).

The battery charge profile can be chosen by fixing the desired CurrRef and FBRef internal reference voltages and by choosing the desired $V=f(I)$ trans-characteristic of the external differential amplifier.

In the Figure 22 is shown a typical Li-lon battery charge profile.
Figure 22. Li-ion battery charge profile


The battery charge loop control can be used to implement a buck type switching regulator. The regulated output voltage will be externally set by a resistor divider network connected to $\mathrm{V}_{\text {REF_FB }}$ pin, as already described and the current protection will be the one implemented internally in the Bridge4 section.

Figure 23. Simple buck regulator


When this control loop is intended to be used as a simple buck regulator, the proper Aux3BatteryCharge bit must be written in the Aux3SwCfg1 register.

The regulator will also implement a soft start strategy.
When L6460 "low power mode" is enabled this regulator will be disabled.
Here after are summarized the primary features of the regulator:

- Internal power switch.
- Nonlinear pulse skipping control.
- Internally generated PWM ( 250 KHz switching frequency).
- Cycle by cycle current limiting using internal current sensor/ external current sense differential amplifier.
- Protected against load short circuit.
- Soft start circuitry to limit inrush current flow from primary supply.
- Under voltage signal (both continuous and latched) accessible through SPI.
- Over temperature protection.

In pulse skipping control PWM the duty cycle must be decided by the user depending on supply voltage and regulated voltage.

Therefore the switching regulator has 4 possible PWM duty cycles that can be changed writing in the Aux3PWMTable[1:0] bits in the Aux3SwCfg1 register according to the Table 31.

Table 29. Battery charger regulator controller PWM specification

| Aux3PWMTable [1:0] | Typical duty cycle value | Comments |
| :---: | :---: | :---: |
| 00 | $10 \%$ |  |
| 01 | $13 \%$ | Default state |
| 10 | $24 \%$ |  |
| 11 | $61 \%$ |  |

## 15 AD converter

L6460 integrates and makes accessible via SPI a general purpose multi-input channel 3.3V analog to digital converter (ADC).
The ADC can be configured to be used as:

- 8-bit resolution ADC.
- 9-bit resolution ADC.

The result of the conversion will always be a 9-bit word; the difference between the two configurations is that, to speed up the conversion, the resolution is reduced when the ADC is used in the 8-bit resolution mode.

The ADC is seen at software level as a 2 channel ADC with different programmable sample times; a finite state machine will sample the requests done through the SPI interface on both the channel and will execute them in sequence.
When used as 8 -bit resolution the ADC can achieve a higher throughput and, if the minimum sample time is used, one conversion is completed in $t=5.5 \mu \mathrm{~s}$. When used as 9-bit resolution ADC the circuit is slower and the minimum sample times are disabled. In that case the conversion will be completed in a time $t=10 \mu \mathrm{~s}$.

The use of ADC type must be decided at the start-up by writing in the one time programmable ADC configuration register; no A/D conversion will be enabled if this register is not set from last power-up sequence.

This ADC can be used to measure some external pins as well as some L6460's internal voltages. The converter is based on a cyclic architecture with an internal sample-and-hold circuit. Sample time can be changed using serial interface to enable good measure of higher impedance sources.

Figure 24. A2D block diagram


The A2D system is enabled by setting the A2DEnable bit to ' 1 ' in the A2DControl register.
The A2DType bit in the A2DConfigX registers selects the A2D active configuration (8-bit resolution or 9-bit) according to the Table 30 .

Table 30. ADC truth table

| A2DEnable | A2DType | A2D operation |
| :---: | :---: | :---: |
| 0 | X | Disabled |
| 1 | 0 | ADC working as a 8-bit ADC |
| 1 | 1 | ADC working as a 9-bit ADC |

The multiplexer channel to be converted can be chosen by writing the A2DChannel1[4:0] or A2DChannel2[4:0] bits in the A2DConfigX register; the channel addresses table is reported in the Table 31.

Table 31. Channel addresses

| A2DChannelX[4:0] (bin.) | Converted channel | Note |
| :---: | :---: | :---: |
| 00000 | $\mathrm{V}_{\text {Supply }}$ scaled | See voltage divider specification. |
| 00001 | $\mathrm{V}_{\text {Supply }{ }^{\text {nt }} \text { scaled }}$ | See voltage divider specification. |
| 00010 | $\mathrm{V}_{\text {ref_2_5 }} \mathrm{V}$ |  |
| 00011 | Temp Sensor1 | Temperature sensor1 |
| 00100 | Temp Sensor2 | Temperature sensor2 |
| 00101 | $\mathrm{V}_{3 \mathrm{v} 3}$ scaled | See voltage divider specification. |
| 0011X | Not used |  |
| 01000 | Not used | 1 |
| 01001 | GPIO[0] | 1. |
| 01010 | GPIO[1] | - |
| 01011 | GPIO[2] | O |
| 01100 | GPIO[3] |  |
| 01101 | GPIO[4] | + 3 |
| 01110 | GPIO[5] |  |
| 01111 | GPIO[6] |  |
| 10000 | GPIO[7] |  |
| 10001 | GPIO[8] clamp | See current DAC circuit |
| 10010 | C GPIO[9] |  |
| 10011 | GPIO[10] |  |
| 10100 | GPIO[11] |  |
| 10101 | GPIO[12] |  |
| 10110 | GPIO[13] |  |
| ( 10111 | GPIO[14] |  |
| 11000 | MuxRefOpAmp1 |  |
| 11001 | MuxRefOpAmp2 |  |
| 11010 | OutStripStepperPhA |  |
| 11011 | OutStripStepperPhB |  |
| 11100 | Not used |  |
| 11101 | ST reserved | References AUX1 switching reg. |
| 11110 | ST reserved | 0.8 V reference voltage |
| 11111 | ST reserved | 1.65 V reference voltage |

The sample time can be changed by modifying the A2DSampleX[2:0] bits in the A2DConfigX register; depending on which is the A2DType bit, the available sample times are reported in Table 32 and Table 33.

Table 32. ADC sample times when working as a 8-bit ADC

| A2DSampleX[2:0] (binary) | Sample time |  |
| :---: | :---: | :---: |
|  | Typ | Unit |
| 000 | $16^{*} T_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 001 | $32^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 010 | $64^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 011 | $128^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 100 | $256^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 101 | $512^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 110 | $1024^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |
| 111 | $2048^{*} \mathrm{~T}_{\mathrm{osc}}$ | $\mu \mathrm{s}$ |

Table 33. ADC sample time when working as a 9-bit ADC

| A2DSampleX[2:0] (binary) | Sample time |  |
| :---: | :---: | :---: |
|  | 2 Typ | Unit |
| 000 | $32 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 001 | $64 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 010 | $128 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 011 | $256 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 100 | $512 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 101 | $1024 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| ) 110 | $2048 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |
| 111 | $4096 * \mathrm{~T}_{\text {osc }}$ | $\mu \mathrm{s}$ |

A conversion on channel 1 can be triggered by writing a logic ' 1 ' in the A2DTrig1 bit in the A2DConfigX register and a conversion on channel 2 can be triggered writing a logic ' 1 ' in the A2DTrig2 bit in the same register. While a request on a channel is pending but not yet completed L6460 will force to logic ' 0 ' the corresponding A2DdoneX bit in the A2DResultX registers and L6460 will not accept other conversion request on that channel.

Continuous conversion on one channel can be accomplished by setting to logic ' 1 ' the A2Dcontinuous $X$ bit in the A2DConfigX register. When A2Dcontinuous $X$ bit is set, other conversions can be accomplished on the other channel; these conversions will be inserted between two conversions of the other channel and the end of the conversion will be signaled using A2DdoneX bit. Of course when a channel is in continuous mode its sample time and channel address cannot be changed.
Continuous conversions on both 2 channels can be also accomplished by setting to logic ' 1 ' the A2Dcontinuous1 and A2Dcontinuous2 bits; the conversions are made in sequence.

### 15.1 Voltage divider specifications

As can be seen in the A2D block diagram, in order to report some voltages in the A2D working range, they are scaled with a resistor divider before the conversion.

Here below are reported the resistor voltage divider specifications:
Table 34. Voltage divider specification

| Parameter | Description | Notes | Min | Typ | Max | Unit |
| :---: | :--- | :--- | :---: | :---: | :---: | :---: |
| $R_{\text {Supply_ratio }}$ | $V_{\text {Supply }}$ divider ratio |  | - | $1 / 15$ | - |  |
| $R_{\text {SupplyInt_ratio }}$ | $V_{\text {Supply Int }}$ divider ratio |  | - | $1 / 15$ | - |  |
| $R_{\text {V3V3_ratio }}$ | $V_{\text {3v3 }}$ divider ratio |  | - | $1 / 2$ | - |  |

## 16 Current DAC circuit

L6460 includes a multiple range 6-bit current sink DAC. The LSB value of this DAC can be selected using the DacRange[1:0] bits in the CurrDacCtrl register.
The output of this circuit is connected to GPIO[8] that is a 5 V tolerant pin. The value of this pin can be converted using ADC. The pin value can be scaled before being converted by enabling the internal resistor divider connected to this pin. If the current sunk by resistor divider is not acceptable the pin voltage can be converted without scaling its value. When the conversion without scaling resistor is chosen a clamping connection is used to avoid voltage compatibility of the pin to the ADC system. The clamping circuit will sink a typical current of half microampere from the pin during the sampling time.

Figure 25. Current DAC block diagram


The circuit is enabled by setting to logic ' 1 ' the EnDac bit in the CurrDacCtrl register then the desired sunk current value is chosen by changing the value of the DacValue[5:0] bits in the same register being DacValue[0] the least significant bit and DacValue[5] the most significant bit.

The current DAC has three possible current ranges that can be selected using the DacRange[1:0] bits in the CurrDacCtrl register. The DAC range selection table is shown in Table 35.

Table 35. Current DAC truth table

| DacRange[1] | DacRange[0] | LSB typical current <br> ILSB $^{\text {typ }}$ | Full scale typical <br> current I I FuLL typ |
| :---: | :---: | :---: | :---: |
| 0 | 0 | Disabled | Disabled |
| 0 | 1 | $10 \mu \mathrm{~A}$ | 0.63 mA |
| 1 | 0 | $100 \mu \mathrm{~A}$ | 6.3 mA |
| 1 | 1 | 1 mA | 63 mA |

By changing LSB current value, all steps will change following this relation:

$$
I_{\text {step }}(N)=N * I_{\text {LSB }}
$$

where $N$ is the value of DacValue[5:0] bits.

## 17 Operational amplifiers

L6460 contains two rail to rail output, high bandwidth internally compensated operational amplifiers supplied by $\mathrm{V}_{\text {GPIO_SPI }}$ pin. The operative supply range is $3.3 \mathrm{~V} \pm 4.5 \%$
Each operational amplifier can have all pin accessible or, to save pins, can be internally configured as a buffer. They can also be used as comparators; to do that the user must disable internal compensation by writing a logic level " 1 " in the OpXCompMode bit in the OpAmpXCtrl register.
in Figure 26 are reported the block diagrams of the two operational amplifiers.
Figure 26. Configurable 3.3 V operational amplifiers


Note: $\quad$ Op1EnPlusRef and Op2EnPlusRef cannot be used to drive external pin so the user must be sure not to enable the path between one of these voltage references and the external pin.

The operational amplifiers are capable to drive a capacitive load in buffer configuration up to a maximum of 100 pF ; for higher capacitance it is necessary to add resistive loads to increase the OP output current, and/or to add a low resistor (10 $\Omega$ ) in series to the load capacitance.

To use the operational amplifiers as comparators the user must disable internal compensation writing a logic one in the OpXDisComp bit in the OpAmpXCtrl register.

## 18 Low voltage power switches

Low voltage power switches are analog switches designed to operate from a single +2.4 V to $+3.6 \mathrm{~V} \mathrm{~V}_{\mathrm{GPIO}} \mathrm{SPI}$ supply. They are intended to provide and remove power supply to low voltage devices. When switched on, they connect the $\mathrm{V}_{\text {GPIO_SPI }}$ pin to their output pin (GPIO[6] for low voltage power switch 1 or GPIO[7] for low voltage power switch 2) thus powering the device connected to it. The turning on and off of each switch can be controlled through serial interface.
L6460 provides 2 low voltage power switches, each of them has current limitation to minimum 150 mA to limit inrush current when charging a capacitive load. When the limit current has been reached, for more than a $\mathrm{T}_{\text {filter }}$ time, then a flag is activated; this flag is latched in the central logic and can be cleared by the firmware. Please note that, in case of capacitive load, the current limit is reached the first time the low power switch is turned on: therefore the user will find a limit flag that must be cleared.
The 2 low voltage power switches can be externally paralleled to obtain a single super low voltage power switch. Low voltage pass switches sink current needed for their functionality from pin $V_{\text {GPIO_SPI, }}$, they never inject current on this pin.

Figure 27. Low power switch block diagram


## 19 General purpose PWM

L6460 includes three general purpose PWM generators that can be redirected on GPIO pins (see Chapter 22). Two of these generators (Aux_PWM_1 and Aux_PWM_2) work with a fixed period $\mathrm{F}_{\text {OSC }} / 512$ and have a programmable duty cycle; the other one (GP_PWM) has a programmable base time clock and a programmable time for both high and low levels.

### 19.1 General purpose PWM generators 1 and 2 (AuxPwm1 and AuxPwm2)

The Duty cycle of these PWM generators can be changed by writing the AuxPwmXCtrl bits (where $X$ can be 1 or 2 ) in the AuxPwm1Ctrl and AuxPwm2Ctrl registers. Their positive duty cycle will change according to the equation:
PWM_X_DUTY = AuxPwmXCtrl[9:0]/512

According to this equation a programmed " 0 " value will cause a $0 \%$ duty cycle (output always at logic level 0).

### 19.2 Programmable PWM generator (GpPwm)

GpPWM has a programmable base clock that can be changed by programming the GpPwmBase[6:0] bits in the GpPwmBase register. The clock will change according to the equation:

$$
\text { PWM_BASE_PERIOD }=(\text { GpPwmBase[6:0] }+1) \times \text { Tosc }
$$

The high and low level duration (expressed in base clock periods), can be programmed writing the GpPwmHigh[7:0] and GpPwmLow[7:0] bits in the GpPwmCtrl register so they will change according to following equations:

```
High_level_Time = GpPwmHigh[7:0] \times PWM_BASE_PERIOD
Low_level_Time = GpPwmLow[7:0] × PWM_BASE_PERIOD
```

The resulting period of the PWM will be:

$$
\text { Period }=(\text { GpPwmHigh[7:0] }+ \text { GpPwmLow[7:0] })+\text { PWM_BASE_PERIOD }
$$

and the positive duty cycle will result:

$$
\text { DutyCycle }=\frac{\text { High_level_Time }}{\text { High_level_Time }+ \text { Low_level_Time }}=\frac{\text { GpPwmHigh[7:0] }}{\text { GpPwmHigh[7:0] + GpPwmLow[7:0] }}
$$

A programmed value of 0 in GpPwmHigh[7:0] and GpPwmLow[7:0] bits will force the PWM generator output to be always at logic level " 0 ".

## 20 Interrupt controller

L6460 contains one programmable interrupt controller that can be used to advice the firmware, through the serial interface, when a certain event happens inside the IC. The output of the interrupt circuit can be also redirected on a GPIO pin therefore the event can be signaled directly to the external circuits.

Figure 28. Interrupt controller diagram


The Table 36 contains the events that can be monitored by the interrupt controller.
Table 36. Interrupt controller event

| Event | Event description | Notes |
| :---: | :--- | :---: |
| Mtr1Fault | Bridge 1 fault (llimit event) |  |
| Mtr2Fault | Bridge 2 fault (llimit event) |  |
| Mtr3Fault | Bridge 3 fault (Ilimit event) |  |
| Mtr4Fault | Bridge 4 fault (Ilimit event) |  |
| nAWAKE | nAWAKE pin low |  |
| SwRegCtrl Ilimit | Switching regulator controller Ilimit event. |  |
| VMainSW Ilimit | Main switching regulator Ilimit event. |  |
| LowPowSw 1 | Low voltage power switch 1 Ilimit event. |  |
| LowPowSw 2 | Low voltage power switch 2 Ilimit event |  |
| Warm | Warming event |  |

Table 36. Interrupt controller event (continued)

| Event | Event description | Notes |
| :---: | :--- | :---: |
| WDWarn | Watch dog warning event |  |
| WD | Watch dog event |  |
| DigCmp | Digital comparator | (1) |
| ADCDone1 | ADC conversion done 1 | (1) |
| ADCDone2 | ADC conversion done 2 |  |
| Vloop1llim | AUX1 llimit event. |  |

1. This event is disabled if the related ADC channel is configured in continuous mode.

Any event detection can be enabled and disabled by setting at logic level 1 the relative enable bit in the interrupt controller configuration register (IntCrtlCfg).

The interrupt controller can be programmed to give a pulse when a monitored event happens or to continuously maintaining the output active until the interrupt condition is finished.

When programmed to signal the enabled events by giving pulses, the interrupt controller can be configured to disable the event that caused the interrupt request until the firmware reenables it writing the relative bit in the control register (IntCrtlCtrl) or to continue to monitor the event.

The GPIO output of this circuit can be programmed to be active high or active low.

## 21 Digital comparator

L6460 includes one digital comparator that can be used to signal, through serial interface, that a channel converted by the ADC is greater, greater-equal, lesser, lesser equal, or equal than a fixed value set by serial interface or than the value converted by the other ADC channel.

This circuit can be used to monitor the temperature of the IC advising the firmware when it reaches a certain value decided by the firmware by setting one ADC channel to do continuous conversions of the temperature sensor.
The circuit operation can be enabled or disabled changing the EnDigCmp bit in the configuration register DigCmpCfg. By setting the DigCmpUpdate[1:0] bits in the configuration register, the comparator can be programmed to update its output in one of the following ways:

- DigCmpUpdate[1:0]=00
- Continuously (each clock).
- DigCmpUpdate[1:0]=01
- Each time a conversion is performed on ADC channel 0.
- DigCmpUpdate[1:0]=10
- Each time a conversion is performed on ADC channel 1.
- DigCmpUpdate[1:0]=11
- ADC state machine driven.

When the last option is selected, the digital comparator will update its output in two different ways depending on the configuration of the ADC converter. If ADC converter is configured to do continuous conversions on both channels, the output of the comparator will be updated when the double conversion is completed. If ADC converter is not configured to do continuous conversions on both channels, the output of the comparator will be updated each time a conversion is completed.

The comparator output can be digitally filtered so that the programmed condition has to be found for three consecutive checks before to be signaled.

The Figure 29 shows the block diagram of digital comparator.

Figure 29. Digital comparator block diagram


In Table 37 is reported the comparison type truth table.
Table 37. Comparison type truth table

| EnDigCmp | SeICmpType[1] | SeICmpType[0] | Comparison type |
| :---: | :---: | :---: | :---: |
| 0 | $X$ | $X$ | Disabled |
| 1 | 0 | 0 | Data0[9:0] $\leq 1^{3} 1 \div$ Data1[9:0] |
| 1 | 0 | 1 | Data0[9:0] = Data1[9:0] |
| 1 | 1 | 0 | Data0[9:0] $>$ Data1[9:0] |
| 1 | 1 | 1 | Data0[9:0] $\leq=$ Data1[9:0] |

In Table 38 is reported the Data0/Data1 selection truth table.
Table 38. DataX selection truth table

| DigCmpSeIChX[1] | DigCmpSeIChX[0] | DataX[9:0] |
| :---: | :---: | :---: |
| 0 | $X$ | DigCmpValue[9:0] |
| 1 | 0 | A2DResult1[8:0] |
| 1 | 1 | A2DResult1[8:0] |

## 22 GPIO pins

Some of the pins of L6460 are indicated as GPIO (General purpose I/O). These pins can be configured to be used in different ways depending on customer application. All GPIOs can be used as digital input/output pins with digital value settable/readable using serial interface or as analog input pins that can be converted using the A2D system. Some of the pins can be used for special purposes: i.e. two of them can be used to access to the pass switch function, other two are used as feedback pins for the auxiliary synchronous switching regulators.

All input Schmitt triggers and output circuitry used for start-up purposes are powered by the internally generated $\mathrm{V}_{3 \mathrm{v} 3}$, while the digital output buffers are powered by $\mathrm{V}_{\text {GPIO_SPI }}$ pin. To ensure independency between $\mathrm{V}_{3 \mathrm{v} 3}$ and $\mathrm{V}_{\text {GPIO_SPI }}$ the GPIOs output drivers are open-drain driver or the high side MOS is in back-to-back configuration to avoid the presence of the body diode between output and supply.
All digital output signals can be inverted before being provided on the relative GPIO pins.
Here below is reported the table with GPIO functions.
Table 39. GPIO functions description

| Pin Name | Function ${ }^{(1)}$ |  |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Input |  | Output |  | Special |  |
|  | Analog | Digital | Analog | Digital |  |  |
| GPIO[0] | - ADC input | - SPI IN |  | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm1 <br> - AuxPwm2 | Start-up configuration pin | Open drain output |
| GPIO[1] | - ADC input <br> - Comp1 In- <br> - Vaux1 F.B. | - SPI IN |  | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm1 <br> - AuxPwm2 |  | Open drain output |
| GPIO[2] | - ADC input <br> - Comp2 In- <br> - Vaux2 F.B. | - SPI IN <br> - IN PWM |  | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm2 <br> - AuxPwm3 |  | Open drain output |
| GPIO[3] | - ADC input | - SPI IN |  | - SPI OUT <br> - AuxPwm2 <br> - AuxGpPwm3 | Start-up configuration pin | Open drain output |
| GPIO[4] | - ADC input | - SPI IN |  | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm1 <br> - AuxPwm3 | Start-up configuration pin | Open drain output |
| GPIO[5] | - ADC input | -SPI IN |  | - SPI OUT <br> - Reg. loop 1 <br> - Comp1 out <br> - AuxPwm3 | Slave Control | Full driver BB powered by $\mathrm{V}_{3 \mathrm{v} 3}$ |

Table 39. GPIO functions description (continued)

| Pin Name | Function ${ }^{(1)}$ |  |  |  |  | Notes |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Input |  | Output |  | Special |  |
|  | Analog | Digital | Analog | Digital |  |  |
| GPIO[6] | - ADC input | - SPI IN | - Low Pow Sw 1 | - SPI OUT <br> - A2DGpo <br> - AuxPwm2 <br> - Comp2 out |  | Full driver connected to $\mathrm{V}_{\text {GPIO_SPI }}$ |
| GPIO[7] | - ADC input | - SPI IN | - Low Pow Sw 2 | - SPI OUT <br> - AuxPwm1 <br> - AuxPwm3 <br> - Comp1 out |  | Full driver connected to $\mathrm{V}_{\text {GPIO_SPI }}$ |
| GPIO[8] | - ADC input | - SPI IN ${ }^{(2)}$ | - CurrDAC | - SPI OUT <br> - AuxPwm1 <br> - AuxPwm3 <br> - Comp2 out | 5 volt input tolerant | Open drain output |
| GPIO[9] | - ADC input <br> - OpAmp1 in+ | - SPI IN <br> - ID 1 <br> - IN PWM |  | - SPI OUT <br> - Interrupt contr. <br> - AuxPwm1 <br> - Reg. loop 3 |  | Full driver connected to $\mathrm{V}_{\text {GPIO_SPI }}$ |
| GPIO[10] | - ADC input <br> - OpAmp1 in- | - SPI IN <br> - ID 2 <br> - IN PWM |  | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm2 <br> - AuxPwm3 |  | Full driver connected to $\mathrm{V}_{\text {GPIO_SPI }}$ |
| GPIO[11] | - ADC input | -SPI IN <br> - IN PWM | - OpAmp1 Out | - SPI OUT <br> - A2DGpo <br> - AuxPwm1 <br> - AuxPwm2 |  | Full driver connected to $\mathrm{V}_{\text {GPIO_SPI }}$ |
| GPIO[12] | - ADC input <br> - OpAmp2 in+ | $\begin{aligned} & \text { - SPI IN } \\ & \text { - STEP_REQ } \end{aligned}$ |  | - SPI OUT <br> - Interrupt ctrl <br> - Comp2 out <br> - Reg. loop 2 |  | Full driver BB (can be powered by $V_{3 v 3}$ with a metal change) |
| GPIO[13] | - ADC input <br> - OpAmp2 in- | - SPI IN |  | - SPI OUT <br> - AuxPwm1 <br> - Reg. loop 3 <br> - AuxPwm3 |  | Full driver connected to $V_{\text {GPIO_SPI }}$ |
| GPIO[14] | - ADC input | - SPI IN | - OpAmp2 Out | - SPI OUT <br> - Interrupt ctrl. <br> - AuxPwm2 <br> - AuxPwm3 |  | Full driver connected to $V_{\text {GPIO_SPI }}$ |

1. In this table are used the abbreviations of the following In Table 40.
2. GPIO[8] input Schmitt trigger is disabled by default (after a reset) to be able to read the digital value from this pin it needs to be enabled writing a logic ' 1 ' in the EnGpio8Digln in CurrDacCtrl register.

Table 40. Abbreviations

| Abbreviation | Meaning |
| :---: | :---: |
| ADC input | Input to the ADC system. |
| SPI IN | Digital state of this pin is readable through SPI. |
| SPI OUT | Digital state of this pin can be set through SPI. |
| BB | Back to back high side driver. |
| Comp1 IN - | This pin can be used as minus input for comparator 1. |
| Comp2 IN - | This pin can be used as minus input for comparator 2. |
| Vaux1 FB | This pin can be used as feedback input for AUX1 regulator obtained by using bridge 3 . |
| A2DGpo | This pin can be used to carry out the A2DGpo value related to the ADC conversion L6460 is doing. |
| Reg. Loop 3 | This pin can be used as output of the regulation loop used by AUX3 regulator obtained by using bridge 4. |
| STEP_REQ | This pin can be used to request a stepper sequencer evolution step. |
| Interrupt Ctrl | This pin can be used to carry out the interrupt controller circuit output. |
| Vaux2 FB | This pin can be used as feedback pin by AUX2 regulator obtained by using bridge 3 |
| IN PWM | This pin can be used to provide an external PWM to bridges. |
| Reg. Loop 1 | This pin can be used as output of the regulation loop used by AUX1 regulator. |
| Comp1 OUT | This pin can be used as output of the comparator 1. |
| AuxPwm1 | This pin can be used to carry out the PWM generated by AuxPwm1 circuit. |
| Low Volt. Pow. Sw. 1 | This pin can be used as output of low voltage power switch 1. |
| Reg. Loop 2 | This pin can be used as output of the regulation loop used by AUX2 regulator. |
| Comp2 OUT | This pin can be used as output of the comparator 2. |
| AuxPwm2 | This pin can be used to carry out the PWM generated by AuxPwm2 circuit. |
| Low Volt. Pow. Sw. 2 | This pin can be used as output of low voltage power switch 2. |
| Reg. Loop 3 | This pin can be used as output of the regulation loop used by AUX3 regulator. |
| AuxPwm3 | This pin can be used to carry out the PWM generated by AuxPwm3 circuit. |
| CurrDAC | This pin can be used to carry out the output of the current DAC circuit. |
| AuxPwm4 | This pin can be used to carry out the PWM generated by AuxPwm4 circuit. |
| OpAmp1 in+ | This pin can be used as operational amplifier 1 non-inverting input. |
| OpAmp1 in- | This pin can be used as operational amplifier 1 inverting input. |
| OpAmp1 Out | This pin can be used as operational amplifier 1 output. |
| OpAmp2 in+ | This pin can be used as operational amplifier 2 non-inverting input. |
| OpAmp2 in- | This pin can be used as operational amplifier 2 inverting input. |

Table 40. Abbreviations (continued)

| Abbreviation | Meaning |
| :---: | :--- |
| OpAmp2 Out | This pin can be used as operational amplifier 2 output. |
| ID 1 | This pin is used to determine the SPI ID1 bit value. |
| ID 2 | This pin is used to determine the SPI ID2 bit value. |
| Slave Control | This pin is used as slave control when the IC is configured as master. |

Hereafter are reported the detailed specifications for each GPIO.
To enable the functionality of the GPIO as output pin, the relative GpioOutEnable[14:0] bit must be enabled in GpioOutEnable register.

Each GPIO could be configured by setting the appropriate GpioXMode[2:0] in the GpioCtrIX register.

### 22.1 GPIO[0]

The GPIO[0] truth table is (for the abbreviation list please refer to Table 40).
Table 41. GPIO[0] truth table

| $\begin{array}{c}\text { State at } \\ \text { StartUp }\end{array}$ | GPIO[0] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  |  |  | Mode[2] \(\left.\begin{array}{c}Mode[1] <br>

Enode[0]\end{array}\right)\)

1. In all configurations in which GPIO[0] is enabled as output:
a) the GPIO[0] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[0] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[0] pin is an open drain output.

Figure 30. GPIO[0] block diagram


### 22.2 GPIO[1]

The GPIO[1] truth table is (for the abbreviation list please refer to Table 40).
Table 42. GPIO[1] truth table

| AUX1Enable <br> or <br> AUX1System | GPIO[1] SPI BITS <br> GpioOut <br> Enable [1] |  |  |  | Mode[2] | Mode[1] |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Function | Note |  |  |  |  |
| 1 | $X$ | $X$ | $X$ | $X$ | AUX1 FB | $(1)$ |
| 0 | 0 | 0 | $X$ | $X$ | HiZ (SPI_IN) |  |
| 0 | 0 | 1 | $X$ | $X$ | Comp1 IN - | $(2)$ |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $(2)$ |
| 0 | 1 | 0 | 0 | 1 | AuxPwm1 | $(2)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm2 | $(2)$ |
| 0 | 1 | 0 | 1 | 1 | InterruptCtrl | $(2)$ |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | $(2)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm1 inverted | $(2)$ |
| 0 | 1 | 1 | 1 | 0 | AuxPwm2inverted | $(2)$ |
| 0 | 1 | 1 | 1 | 1 | IntCtrlinverted | $(2)$ |

1. AUX1Enable or AUX1System bit $=1$ represent the case in which $A U X 1$ is used as a system or not system regulator.
2. In all configurations in which GPIO[1] is enabled as output:
a) the GPIO[1] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[1] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[1] pin is an open drain output.

Figure 31. GPIO[1] block diagram


### 22.3 GPIO[2]

The GPIO[2] truth table is (for the abbreviation list please refer to Table 40).

Table 43. GPIO[2] truth table

| AUX2Enable or AUX2System | GPIO[1] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> Enable [1] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | AUX2 FB | (1) |
| 0 | 0 | 0 | X | X | HiZ (SPI_IN) |  |
| 0 | 0 | 1 | X | X | Comp1 IN - | (2) |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | (2) |
| 0 | 1 | 0 | 0 | 1 | AuxPwm2 | (2) |
| 0 | 1 | 0 | 1 | 0 | AuxPwm3 | (2) |
| 0 | 1 | 0 | 1 | 1 | InterruptCtrl | (2) |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | (2) |
| 0 | 1 | 1 | 0 | 1 | AuxPwm2 inverted | (2) |
| 0 | 1 | 1 | 1 | 0 | AuxPwm3 inverted | (2) |
| 0 | 1 | 1 | 1 | 1 | IntCtrlinverted | (2) |

1. AUX2Enable or AUX2System bit $=1$ represent the case in which AUX1 is used as a System or Not System regulator.
2. In all configurations in which GPIO[2] is enabled as output:
a) the GPIO[2] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[2] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) please note that GPIO[2] output is directly connected to ExtPWM3 input for Bridge 3 or 4 and therefore particular care must be taken in order to avoid wrong PWM signals when ExtPWM3 is selected for bridge 3 or 4;
d) the GPIO[2] pin is an open drain output.

Figure 32. GPIO[2] block diagram


### 22.4 GPIO[3]

The GPIO[3] truth table is (for the abbreviation list please refer to Table 40).

Table 44. GPIO[3] truth table

| State at <br> StartUp | GPIO[3] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> Enable [3] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | Detection of StartUp config | See <br> Chapter 8 |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $\mathbf{N}^{(1)}$ |
| 0 | 1 | 0 | 0 | 1 | AuxPwm1 | $(1)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm2 | $(1)$ |
| 0 | 1 | 0 | 1 | 1 | AuxPwm2 | $(1)$ |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | $(1)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm1 inverted | $(1)$ |
| 0 | 1 | 1 | 1 | 0 | AuxPwm2 inverted | $(1)$ |
| 0 | 1 | 1 | 1 | 1 | AuxPwm3 inverted | $(1)$ |

1. In all configurations in which GPIO[3] is enabled as output:
a) the GPIO[3] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[3] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[3] pin is an open drain output.

Figure 33. GPIO[3] block diagram


### 22.5 GPIO[4]

The GPIO[4] truth table is (for the abbreviation list please refer to Table 40).

Table 45. GPIO[4] truth table

| State at <br> StartUp | GPIO[4] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> Enable [4] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | Detection of StartUp config | See <br> Chapter 8 |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $\mathbf{( 1 )}^{(1)}$ |
| 0 | 1 | 0 | 0 | 1 | Interrupt Ctrl | $(1)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm1 | $(1)$ |
| 0 | 1 | 0 | 1 | 1 | AuxPwm3 | $(1)$ |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | $(1)$ |
| 0 | 1 | 1 | 0 | 1 | Interrupt Ctrl | $(1)$ |
| 0 | 1 | 1 | 1 | 0 | AuxPwm1 inverted | $(1)$ |
| 0 | 1 | 1 | 1 | 1 | AuxPwm3 inverted | $(1)$ |

1. In all configurations in which GPIO[4] is enabled as output:
a) the GPIO[4] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[4] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[4] pin is an open drain output.

Figure 34. GPIO[4] block diagram


### 22.6 GPIO[5]

The GPIO[5] truth table is (for the abbreviation list please refer to Table 40).
Table 46. GPIO[5] truth table

| Master ${ }^{(1)}$ | AUX1 <br> system and Vloop1 external ${ }^{(2)}$ | GPIO[5] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | GpioOut enable[5] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | X | Slave control |  |
| 0 | 1 | X | X | X | X | Reg Loop1 OUT | (3) |
| 0 | 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 0 | 1 | 0 | 0 | 0 | SPI OUT | (3) |
| 0 | 0 | 1 | 0 | 0 | 1 | Comp10UT | (3) |
| 0 | 0 | 1 | 0 | 1 | 0 | Reg Loop1 OUT | (3) |
| 0 | 0 | 1 | 0 | 1 | 1 | AuxPwm3 | (3) |
| 0 | 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | (3) |
| 0 | 0 | 1 | 1 | 0 | 1 | Comp1OUT inverted | (3) |
| 0 | 0 | 1 |  | $1$ | 0 | Reg Loop1 OUT inverted | (3) |
| 0 | 0 | 1 | - 1 | 1 | 1 | AuxPwm3 inverted | (3) |

1. Master bit is at logic level " 1 " when L 6460 is used as a master device (seeChapter 8 )
2. This bit is at logic level " 1 " if AUX1 regulator is a system regulator but its power stage is externally realized and therefore the regulation loop is not used to drive bridge 3). In this case Vloop1lsSys bit will be at logic level "1", while Vloop1OnMtr3SideA and Vloop1OnMtr3SideB bits will be at logic level "0" in CoreConfigReg register.
3. In all configurations in which GPIO[5] is enabled as output:
a) the GPIO[5] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[5] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[5] pin is a rail to rail, back to back output supplied by $\mathrm{V}_{3 \mathrm{v} 3}$.

Figure 35. GPIO[5] block diagram


### 22.7 GPIO[6]

The GPIO[6] truth table is (for the abbreviation list please refer to Table 40):
Table 47. GPIO[6] truth table

| StdByMode | AEnLow VSw[1] | GPIO[6] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | GpioOut enable[6] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | X | Low Volt. Pow. Sw. 1 |  |
| 0 | 1 | X | X | X | X | Low Volt. Pow. Sw. 1 | (1) |
| 0 | 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 0 | 1 | 0 | 0 | 0 | SPI OUT | (2) |
| 0 | 0 | 1 | 0 | 0 | 1 | A2DGpo | (2) |
| 0 | 0 | 1 | 0 | 1 | 0 | AuxPwm2 | (2) |
| 0 | 0 | 1 | 0 | 1 | 1 | Comp2OUT | (2) |
| 0 | 0 | 1 | 1 | 0 | 0 | A2DGpo inverted | (2) |
| 0 | 0 | 1 | 1 | 0 | 1 | AuxGpPwm2 inverted | (2) |
| 0 | 0 | 1 | 1 | 1 | 1 | Comp2OUT inverted | (2) |

1. When EnLowVSw[1]= '1' the GpioOutEnable[6] bit is forced to 0 .
2. In all configurations in which GPIO[6] is enabled as output:
a) the GPIO[6] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[6] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[6] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI }}$

Figure 36. GPIO[6] block diagram


### 22.8 GPIO[7]

The GPIO[7] truth table is (for the abbreviation list please refer to Table 40).
Table 48. GPIO[7] truth table

| EnLowVSw[2] | GPIO[7] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[7] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | $X$ | $X$ | $X$ | $X$ | Low Volt. Pow. Sw. 2 | (1) |
| 0 | 0 | $X$ | $X$ | $X$ | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $\left({ }^{(2)}\right.$ |
| 0 | 1 | 0 | 0 | 1 | AuxPwm1 | $(2)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm3 | $(2)$ |
| 0 | 1 | 0 | 1 | 1 | Comp1OUT | $(2)$ |
| 0 | 1 | 1 | 0 | 0 | AuxPwm1 inverted | $(2)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm3 inverted | $(2)$ |
| 0 | 1 | 1 | 1 | 1 | Comp1OUT inverted | $(2)$ |

1. When EnLowVSw[2] = ' 1 ' the GpioOutEnable[7] bit is forced to 0 .
2. In all configurations in which GPIO[7] is enabled as output:
a) the GPIO[7] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[7] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[7] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 37. GPIO[7] block diagram


### 22.9 GPIO[8]

The GPIO[8] truth table is (for the abbreviation list please refer to Table 40).
Table 49. GPIO[8] truth table

| EnDac ${ }^{(1)}$ | GPIO[8] SPI bits |  |  |  | Function (2) | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[8] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | $(3)$ |  |
| 0 | 0 | X | X | X | HiZ (SPI_IN) | $(4)$ |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $(4)$ |
| 0 | 1 | 0 | 0 | 1 | AuxPwm1 | $(4)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm3 | $(4)$ |
| 0 | 1 | 0 | 1 | 1 | Comp2OUT | $(4)$ |
| 0 | 1 | 1 | 0 | 0 | AuxPwm1 <br> inverted | $(4)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm3 <br> inverted | $(4)$ |
| 0 | 1 | 1 | 1 | 1 | Comp2OUT inverted | $(4)$ |

1. The EnDAC bit in the CurrDacCtrl register enables the Current DAC (seeChapter 17)
2. This pin is 5 volt input tolerant.
3. When EnDAC = ' 1 ' the GpioOutEnable[8] bit is forced to 0 . The current DAC circuit is directly connected to GPIO[8] pin so as soon as it is enabled it will sink current from pin.
4. The GPIO[8] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function). To avoid affecting the precision of CurrDAC when this is used to sink very low currents, it is necessary to enable the digital input functionality of GPIO[8]. Therefore to read their values through SPI interface (SPI_IN function), it is necessary to enable the EnGpio8Digln bit in the CurrDacCtrl register.

Figure 38. GPIO[8] block diagram


### 22.10 GPIO[9]

The GPIO[9] truth table is (for the abbreviation list please refer to Table 40).
Table 50. GPIO[9] truth table

| Op1EnPlusPin ${ }^{(1)}$ | GPIO[9] SPI bits |  |  |  | Function ${ }^{(2)}$ | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[9] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | OpAmp1 in+ | $\left({ }^{(3)}\right.$ |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $(4)$ |
| 0 | 1 | 0 | 0 | 1 | Interrupt Ctrl | $(4)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm2 | $(4)$ |
| 0 | 1 | 0 | 1 | 1 | Reg Loop 3 | $(4)$ |
| 0 | 1 | 1 | 0 | 0 | Interrupt Ctrl inverted | $(4)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm2 inverted | $(4)$ |
| 0 | 1 | 1 | 1 | 1 | Reg Loop 3 inverted | $(4)$ |

1. The Op1EnPlusPin bit in the OpAmp1Ctrl register enables the connection of the positive input of Op1 to GPIO[9] pin.
2. The GPIO[9] pin is used by the system when firmware requires the ID read action (Chapter 25)
3. When Op1EnPlusPin = ' 1 ' the GpioOutEnable[9] bit is forced to 0 .
4. In all configurations in which GPIO[9] is enabled as output:
a)the GPIO[9] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[9] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) please note that GPIO[9] output is directly connected to ExtPWM1 input for Bridge 1 or 2 and therefore particular care must be taken in order to avoid wrong PWM signals when ExtPWM1 is selected for bridge 1 or 2;
d)the GPIO[9] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 39. GPIO[9] block diagram


### 22.11 GPIO[10]

The GPIO[10] truth table is (for the abbreviation list please refer to Table 40).
Table 51. GPIO[10] truth table

| Op1EnPlusPin ${ }^{(1)}$ | GPIO[10] SPI bits |  |  |  | Function (2) | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[10] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | OpAmp1 in- | (3) |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $(4)$ |
| 0 | 1 | 0 | 0 | 1 | Interrupt Ctrl | $(4)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm2 | $(4)$ |
| 0 | 1 | 0 | 1 | 1 | AuxPwm3 | $(4)$ |
| 0 | 1 | 1 | 0 | 0 | Interrupt Ctrl inverted | $(4)$ |
| 0 | 1 | 1 | 0 | 1 | AuxPwm2 inverted | $(4)$ |
| 0 | 1 | 0 | 0 | 0 | AuxPwm3 inverted | $(4)$ |

1. The Op1EnMinusPin bit in the OpAmp1Ctrl register enables the connection of the positive input of Op1 to GPIO[10] pin.
2. The GPIO[10] pin is used by the system when firmware requires the ID read action (Chapter 25)
3. When Op1EnPlusPin = ' 1 ' the GpioOutEnable[10] bit is forced to 0 .
4. In all configurations in which GPIO[10] is enabled as output:
a) the GPIO[10] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[10] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) please note that GPIO[10] output is directly connected to ExtPWM2 input for bridge 1 or 2 and therefore particular care must be taken in order to avoid wrong PWM signals when ExtPWM2 is selected for bridge 1 or 2;
d) the GPIO[10] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 40. GPIO[10] block diagram


### 22.12 GPIO[11]

The GPIO[11] truth table is (for the abbreviation list please refer to Table 40).
Table 52. GPIO[11] truth table

| EnOpI (1) | GPIO[11] SPI bits |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[11] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X |  | ${ }^{(2)}$ |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $\left({ }^{(3)}\right.$ |
| 0 | 1 | 0 | 0 | 1 | A2DGpo | $(3)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm1 | $(3)$ |
| 0 | 1 | 0 | 1 | 1 | AuxPwm2 | $(3)$ |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | $(3)$ |
| 0 | 1 | 1 | 0 | 1 | A2DGpo inverted | $(3)$ |
| 0 | 1 | 1 | 1 | 0 | AuxPwm1 inverted | $(3)$ |
| 0 | 1 | 1 | 1 | 1 | AuxPwm2 inverted | $(3)$ |

1. The EnOp1 bit in the OpAmp1Ctrl register enables the operational amplifier 1.
2. When EnOp1 = ' 1 ' the GpioOutEnable[11] bit is forced to 0 .
3. In all configurations in which GPIO[11] is enabled as output:
a) the GPIO[11] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[11] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) please note that GPIO[11] output is directly connected to ExtPWM4 input for bridge 3 or 4 and therefore particular care must be taken in order to avoid wrong PWM signals when ExtPWM4 is selected for bridge 3 or 4;
d) the GPIO[11] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 41. GPIO[11] block diagram


### 22.13 GPIO[12]

The GPIO[12] truth table is (for the abbreviation list please refer to Table 40.
Table 53. GPIO[12] truth table

| AUX2enable or AUX2syste $m^{(1)}$ | Op2En <br> PlusPin | GPIO[12] SPI bits |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | GpioOut enable[12] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | X | RegLoop2 |  |
| 0 | 1 | X | X | X | X | OpAmp2 in+ | (2) |
| 0 | 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 0 | 1 | 0 | 0 | 0 | SPI OUT | (3) |
| 0 | 0 | 1 | 0 | 0 | 1 | Interrupt Ctrl | (3) |
| 0 | 0 | 1 | 0 | 1 | 0 | Comp2OUT | (3) |
| 0 | 0 | 1 | 0 | 1 | 1 | RegLoop2 | (3) |
| 0 | 0 | 1 | 1 | 0 | + 0 | Interrupt Ctrl inverted | (3) |
| 0 | 0 | 1 | 1 | 0 | 1 | Comp2OUT inverted | (3) |
| 0 | 0 | 1 | 1 | $C^{1}$ | 1 | RegLoop2 inverted | (3) |

1. AUX2Enable or AUX2System bit $=1$ represent the case in which AUX2 is used as a regulator (system or not system).
2. When Op2EnPlusPin = ' 1 ' the GpioOutEnable[11] bit is forced to 0 .
3. In all configurations in which GPIO[12] is enabled as output:
a) the GPIO[12] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[12] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) please note that GPIO[12] output is directly connected to StepCmd input for stepper driver and therefore particular care must be taken in order to avoid wrong PWM signals when StepCmd is selected for stepper driver (STEP_REQUEST function)
d) the GPIO[12] pin is a rail to rail, back to back output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 42. GPIO[12] block diagram


### 22.14 GPIO[13]

The GPIO[13] truth table is (for the abbreviation list please refer to Table 40).
Table 54. GPIO[13] truth table

| $\begin{gathered} \text { Op2En } \\ \text { mimusPin }^{(1)} \end{gathered}$ | GPIO[13] SPI BITS |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut enable[13] | Mode[2] | Mode[1] | Mode[0] |  |  |
| 1 | X | X | X | X | OpAmp2 in- | (2) |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | (3) |
| 0 | 1 | 0 | 0 | 1 | AuxPwm1 | (3) |
| 0 | 1 | 0 | 1 | 0 | Reg Loop 3 | (3) |
| 0 | 1 | 0 | 1 | 1 | AuxPwm3 | (3) |
| 0 | 1 | 1 | 0 | 0 | AuxPwm1 inverted | (3) |
| 0 | 1 | 1 | 0 | 1 | Reg Loop 3 inverted | (3) |
| 0 | 1 | 1 | 1 | 1 | AuxPwm3 inverted | (3) |

1. The Op2EnMinusPin bit in the OpAmp2Ctrl register enables the connection of the positive input of Op1 to GPIO[13] pin.
2. When Op2EnMinusPin = ' 1 ' the GpioOutEnable[13] bit is forced to 0 .
3. In all configurations in which GPIO[9] is enabled as output:
a) the GPIO[13] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[13] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[13] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI. }}$

Figure 43. GPIO[13] block diagram


### 22.15 GPIO[14]

The GPIO[14] truth table is (for the abbreviation list please refer to Table 40).
Table 55. GPIO[14] truth table

| EnOp2 $^{(1)}$ | GPIO[14] SPI bits |  |  |  | Function | Note |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | GpioOut <br> enable[14] | Mode[2] | Mode[1] | Mode[0] |  |  |
|  | X | X | X | X | OpAmp2 Out |  |
| 0 | 0 | X | X | X | HiZ (SPI_IN) |  |
| 0 | 1 | 0 | 0 | 0 | SPI OUT | $(3)$ |
| 0 | 1 | 0 | 0 | 1 | Interrupt Ctrl | $(3)$ |
| 0 | 1 | 0 | 1 | 0 | AuxPwm2 | $(3)$ |
| 0 | 1 | 0 | 1 | 1 | AuxPwm3 | $(3)$ |
| 0 | 1 | 1 | 0 | 0 | SPI OUT inverted | $(3)$ |
| 0 | 1 | 1 | 0 | 1 | Interrupt Ctrl inverted | $(3)$ |
| 0 | 1 | 1 | 1 | 0 | AuxPwm2 inverted | $(3)$ |
| 0 | 1 | 1 | 1 | 1 | AuxPwm3 inverted | $(3)$ |

1. The EnOp2 bit in the OpAmp2Ctrl register enables the operational amplifier 2.
2. When EnOp2 = ' 1 ' the GpioOutEnable[14] bit is forced to 0 .
3. In all configurations in which GPIO[14] is enabled as output:
a) the GPIO[14] pin can be always used as an analog input to the ADC system (ADC function) by writing its address in the A2DChannelX[4:0] in the A2DConfigX register and starting a conversion;
b) the GPIO[14] pin can be always used as a digital input so its value can be always read through SPI interface (SPI_IN function);
c) the GPIO[14] pin is a rail to rail output supplied by $\mathrm{V}_{\text {GPIO_SPI }}$

Figure 44. GPIO[14] block diagram


## 23 Serial interface

L6460 can communicate with an external microprocessor by using an integrated slave SPI (serial protocol interface). Through this interface almost all L6460 functionalities can be controlled and all the ICs can be seen as a register map made by 128 register of 16-bit each.

The SPI is a simple industry standard communications interface commonly used in embedded systems and it has the following four I/O pins:

- MISO (master input slave output)
- MOSI (master output slave input)
- SCLK (serial clock [controlled by the master])
- $\quad \mathrm{nSS}$ (slave select active low [controlled by the master])

The "MISO" (master in, slave out) signal carries synchronous data from the slave to the master device. The MOSI (master out, slave in) signal carries synchronous data from the master to the slave device. The SCLK signal is driven by the master, synchronizing all data transfers. Each SPI slave device has one nSS signal that is an active-low slave input/master output pin. Slave devices do not respond to transactions unless their nSS input signal is driven low. Master device interfacing with multiple SPI slave devices has an nSS signal for each slave device.

L6460 will maintain its MISO pin in high impedance until it does not recognize its address in serial frame.

### 23.1 Read transaction

A read transaction (see Figure 45) is always started by the master device that lowers the nSS pin. The other bits are then sent on the MOSI pin with this order:

1. 7-bit representing the address of the register that must be read (MSB first $\left[A_{6} \ldots A_{0}\right]$ );
2. 2-bit that must be " 10 " for a read transaction;
3. 2-bit representing L6460 IC address;
4. 1-bit reserved for future use that must be set at "0".

At this point the data stored in the register at the selected address will be shifted out on the MISO pin.
The read operation is terminated by raising the signal on nSS pin.

Figure 45. SPI read transaction


### 23.2 Write transaction

A write transaction (see Figure 46) is always started by the master lowering the signal on nSS pin. The other bits are then sent on the MOSI pin with this order:

1. 7-bit representing the address of the register that must be written (MSB first [A6...A0]);
2. 2-bit that must be " 01 " for a read transaction;
3. 2-bit representing L6460 IC address;
4. 1-bit reserved for future use that must be set at "0".

The data to be written (MSB first D15...D0) are then read from MOSI pin. The length of data field can be 16 or 20 bits, but only the first 16-bit are accepted as valid data. Data is latched on rising edge of the nSS line.

Figure 46. SPI write transaction


The SPI input and output timing definitions are shown in the Table 5 on page 17

Figure 47. SPI input timing diagram


Figure 48. SPI output timing diagram


## 24 Registers list

Many of the L6460 functionalities are controlled or can be supervised by accessing to the relative register through serial interface. All these registers can be seen from the user (microcontroller) point of view as a register table. Each register is one word wide (16-bit) and can be read using a 7-bit address

Table 56. Register address map

| Address[6:0] (binary) | Name | Comment | Address[6:0] (binary) | Name | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 000_0000 | DevName | Read only | 100_0000 | AuxPwm1Ctrl |  |
| 000_0001 | CoreConfigReg |  | 100_0001 | AuxPwm2Ctrl | 1 |
| 000_0010 | ICTemp |  | 100_0010 | GpPwm3Base |  |
| 000_0011 | ICStatus |  | 100_0011 | GpPwm3Ctrl |  |
| 000_0100 | EnTestRegs |  | 100_0100 | 『 |  |
| 000_0101 | SampleID |  | 100_0101 | , |  |
| 000_0110 | WatchDogCfg |  | 100_0110 | IntCtrlCfg |  |
| 000_0111 | WatchDogStatus |  | 100_0111 | IntCtrlCtrl |  |
| 000_1000 | SoftResReg |  | 100_1000 | DigCmpCfg |  |
| 000_1001 |  |  | 100_1001 | DigCmpValue |  |
| 000_1010 |  |  | 100_1010 |  |  |
| 000_1011 |  |  | 100_1011 |  |  |
| 000_1100 | HibernateStatus |  | 100_1100 |  |  |
| 000_1101 | HibernateCmd |  | 100_1101 |  |  |
| 000_1110 |  |  | 100_1110 |  |  |
| 000_1111 | Mtr1_2PwrCtrl |  | 100_1111 |  |  |
| 001_0000 | MainVSwCfg |  | 101_0000 | A2DControl |  |
| 001_0001 |  |  | 101_0001 | A2DConfig1 |  |
| 001_0010 | MainlinCfg |  | 101_0010 | A2DResult1 |  |
| 001_0011 |  |  | 101_0011 | A2DConfig2 |  |
| 001_0100 | SwCtrCfg |  | 101_0100 | A2DResult2 |  |
| 001_0101 |  |  | 101_0101 |  |  |
| 001_0110 |  |  | 101_0110 |  |  |
| 001_0111 |  |  | 101_0111 |  |  |
| 001_1000 | StdByMode |  | 101_1000 | GpioOutEnable |  |
| 001_1001 |  |  | 101_1001 | GpioCtrl1 |  |
| 001_1010 |  |  | 101_1010 | GpioCtrl2 |  |
| 001_1011 |  |  | 101_1011 | GpioCtrl3 |  |

Table 56. Register address map (continued)

| Address[6:0] (binary) | Name | Comment | Address[6:0] (binary) | Name | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 001_1100 |  |  | 101_1100 | GpioPadVal | Read only |
| 001_1101 |  |  | 101_1101 | GpioOutVal |  |
| 001_1110 |  |  | 101_1110 |  |  |
| 001_1111 |  |  | 101_1111 |  |  |
| 010_0000 | Mtrs1_2Cfg |  | 110_0000 | LowVSwitchCtrl |  |
| 010_0001 | Mtr1Cfg |  | 110_0001 |  |  |
| 010_0010 | Mtr1Ctrl |  | 110_0010 |  |  |
| 010_0011 | Mtr1Limit |  | 110_0011 |  | - |
| 010_0100 | Mtr2Cfg |  | 110_0100 | OpAmpCtrl1 |  |
| 010_0101 | Mtr2Ctrl |  | 110_0101 | OpAmpCtrl2 |  |
| 010_0110 | Mtr2Limit |  | 110_0110 | $\sqrt{3}$ |  |
| 010_0111 |  |  | 110_0111 | 1 |  |
| 010_1000 | Mtrs3_4Cfg |  | 110_1000 |  |  |
| 010_1001 | Mtr3Cfg |  | 110_1001 |  |  |
| 010_1010 | Mtr3Ctrl |  | 110_1010 |  |  |
| 010_1011 | Mtr31Limit | , | 110_1011 |  |  |
| 010_1100 | Mtr4Cfg |  | 110_1100 |  |  |
| 010_1101 | Mtr4Ctrl |  | 110_1101 |  |  |
| 010_1110 | Mtr4ILimit |  | 110_1110 |  |  |
| 010_1111 |  |  | 110_1111 |  |  |
| 011-0000 | StpCfg1 |  | 111_0000 |  |  |
| 011_0001 | StpCfg2 |  | 111_0001 |  |  |
| , 011_0010 | StpCtrl |  | 111_0010 |  |  |
| 011_0011 | StpCmd |  | 111_0011 |  |  |
| 011_0100 | StpTest |  | 111_0100 |  |  |
| 011_0101 | Aux1SwCfg |  | 111_0101 |  |  |
| 011_0110 | Aux2SwCfg |  | 111_0110 |  |  |
| 011_0111 | Aux3SwCfg1 |  | 111_0111 |  |  |
| 011_1000 | Aux3SwCfg2 |  | 111_1000 |  |  |
| 011_1001 | Power Mode Control |  | 111_1001 |  |  |
| 011_1010 |  |  | 111_1010 |  |  |
| 011_1011 |  |  | 111_1011 | REV_MFCT |  |
| 011_1100 | CurrDacCtrl |  | 111_1100 | RESERVED |  |

Table 56. Register address map (continued)

| Address[6:0] <br> (binary) | Name | Comment | Address[6:0] <br> (binary) | Name | Comment |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $011 \_1101$ |  |  | $111 \_1101$ | RESERVED |  |
| $011 \_1110$ |  |  | $111 \_1110$ | RESERVED |  |
| $011 \_1111$ |  |  | $111 \_1111$ | RESERVED |  |

## 25 Schematic examples

Figure 49. Application with 2 DC motors, 1 stepper motor and 3 power supplies


Figure 50. Application with 2 DC motors, a battery charger and 5 power supplies


## 26 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
ECOPACK is an ST trademark.
Figure 51. TQFP64 mechanical data an package dimensions

| DIM. | mm |  |  | inch |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN. | TYP. | MAX. | MIN. | TYP. | MAX. |
| A |  |  | 1.20 |  |  | 0.0472 |
| A1 | 0.05 |  | 0.15 | 0.002 |  | 0.006 |
| A2 | 0.95 | 1.00 | 1.05 | 0.0374 | 0.0393 | 0.0413 |
| b | 0.17 | 0.22 | 0.27 | 0.0066 | 0.0086 | 0.0086 |
| c | 0.09 |  | 0.20 | 0.0035 |  | 0.0078 |
| D | 11.80 | 12.00 | 12.20 | 0.464 | 0.472 | 0.480 |
| D1 | 9.80 | 10.00 | 10.20 | 0.386 | 0.394 | 0.401 |
| D2 | 2.00 |  |  | 0.787 |  |  |
| D3 |  | 7.50 |  |  | 0.295 |  |
| E | 11.80 | 12.00 | 12.20 | 0.464 | 0.472 | 0.480 |
| E1 | 9.80 | 10.00 | 10.20 | 0.386 | 0.394 | 0.401 |
| E2 | 2.00 |  |  | 0.787 |  |  |
| E3 |  | 7.50 |  |  | 0.295 |  |
| e |  | 0.50 |  |  | 0.0197 |  |
| L | 0.45 | 0.60 | 0.75 | 0.0177 | 0.0236 | 0.0295 |
| L1 |  | 1.00 |  |  | 0.0393 |  |
| k | $0^{\circ}$ | $3.5^{\circ}$ | 7 | $7^{\circ}$ | $00^{\circ}$ | $3.5^{\circ}$ |
| ccc |  |  | 0.080 |  |  | $7^{\circ}$ |

OUTLINE AND
MECHANICAL DATA


TQFP64 (10x10x1.0mm) Exposed Pad Down


## 27 Revision history

Table 57. Document revision history

| Date | Revision | Changes |
| :---: | :---: | :--- |
| 02-Jul-2010 | 1 | Initial release. |

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